

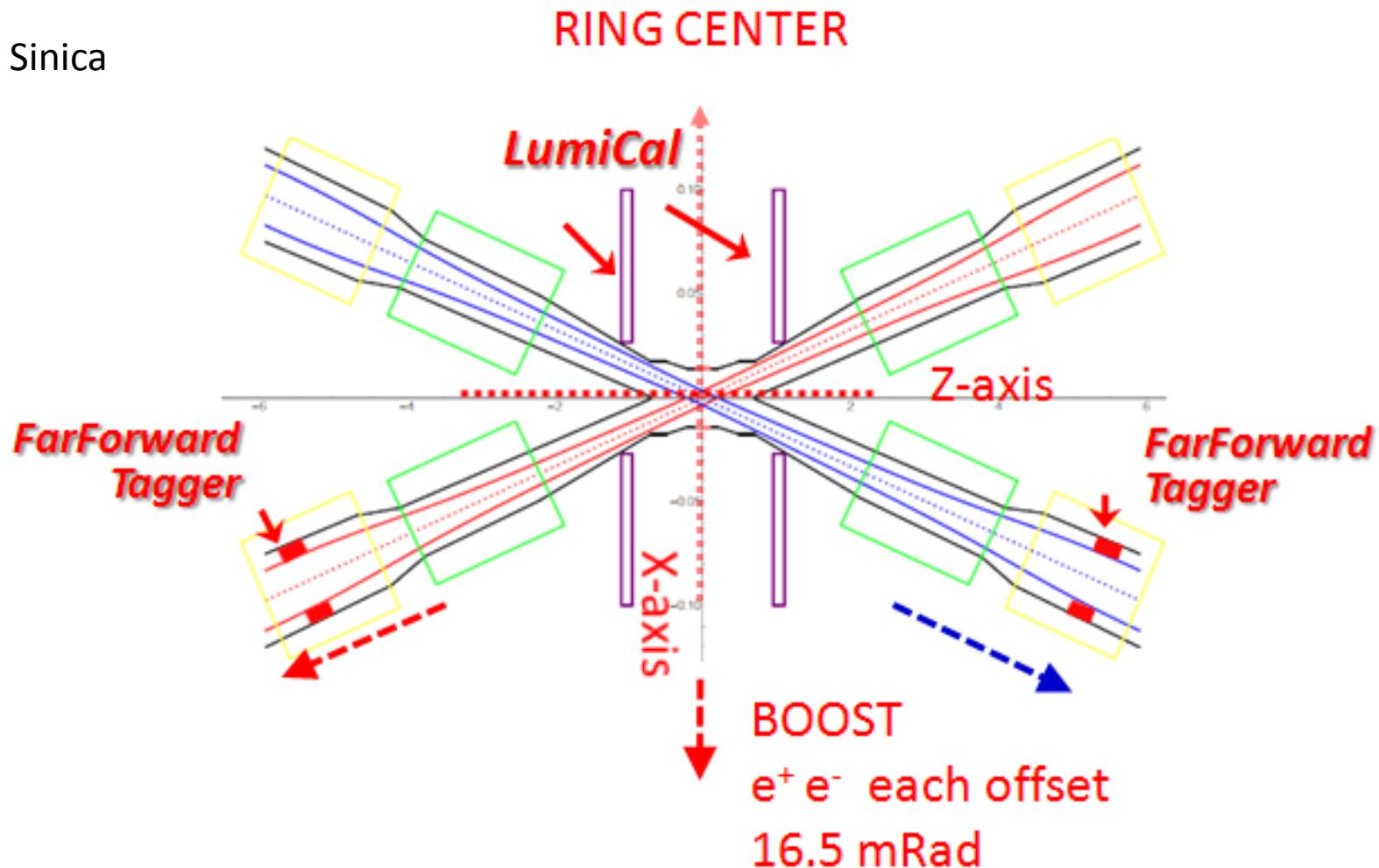
LumiCal Design Options

2020.04.15

15:00 indico.ihep.ac.cn/event/11684/

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Outline

- **BHLUMI : Bhabha cross section**
 - boost by beam crossing, small beam pipe
 - $\theta < 30 \text{ mRad} \rightarrow \sigma(\text{Bhabha}) > \sim 50 \text{ nb}$
 - OVAL beampipe to optimize coverage
- **GEANT : intrinsic spatial resolution**
 - beampipe cone shape
 - beampipe tube shape
- **LumiDET : beampipe r, flange z $\rightarrow \theta < 30 \text{ mRad}$**
 - Inner-Det Si volume : wafer surrounding beampipe
 - beampipe Flange : Si disks
 - Q-pole front : calorimeter : LYSO $2 \times 2 \text{ mm}^2$ bars
 - outgoing beampipe : Far-Forward Tagger

Luminosity measurement

- Reference to Z-lineshape, $e^+e^- \rightarrow Z \rightarrow q\bar{q}$

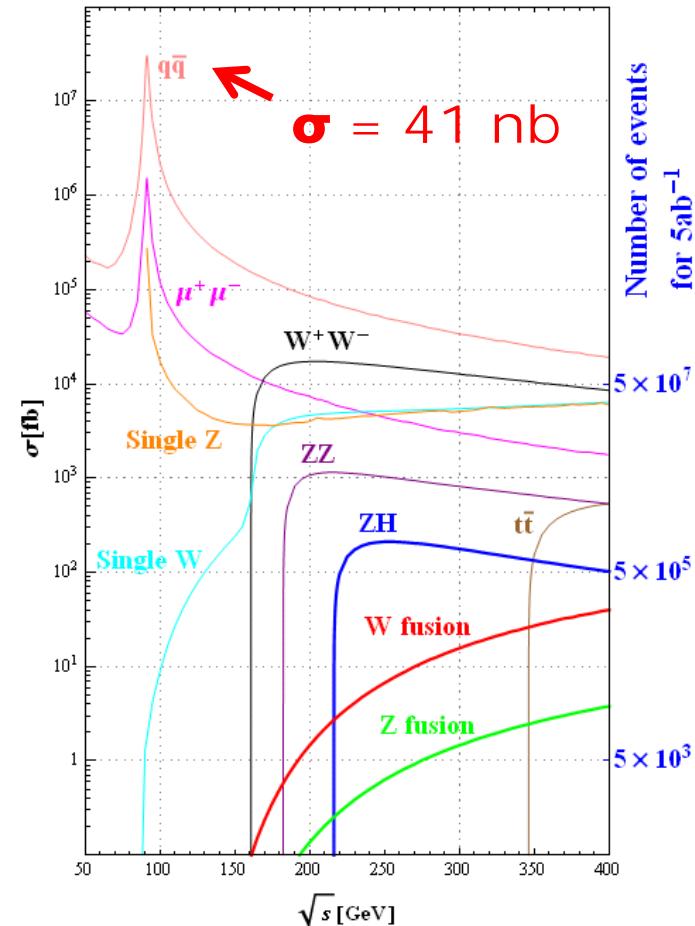
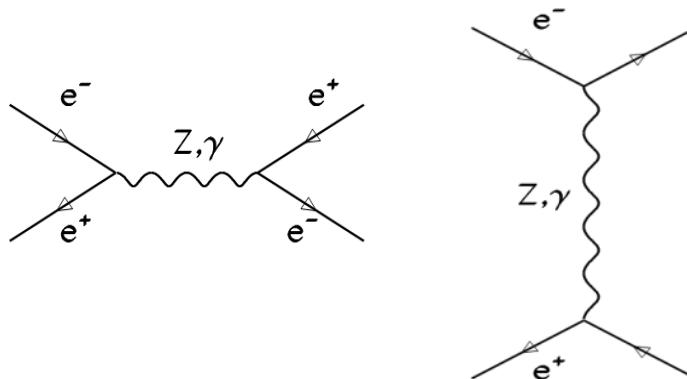
- Luminosity of e^+e^- collisions
by measuring **Bhabha** elastics scattering

$$e^+e^- \rightarrow e^+e^-$$

- QED process, theoretical $< 0.1\%$ precision
- triggering on a pair of scattered e^+e^-

$$\mathcal{L} = \frac{1}{\varepsilon} \frac{N_{\text{acc}}}{\sigma^{\text{vis}}} \quad \sigma = \frac{16\pi\alpha^2}{s} \cdot \left(\frac{1}{\theta_{min}^2} - \frac{1}{\theta_{max}^2} \right)$$

LO
diagrams



Luminosity precision

Dominant systematic error

$$\delta L/L \sim 2 \delta\theta/\theta_{min}$$

For a precision of $\delta L/L < 10^{-3}$

LumiCal at $z = \pm 1$ m, $\rightarrow \theta_{min} = 30$ mRad

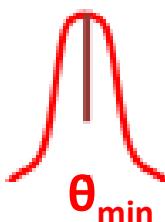
$$\rightarrow \delta\theta = 15 \mu\text{Rad} \text{ or } dr = 15 \mu\text{m}$$

Error due to offset on Z

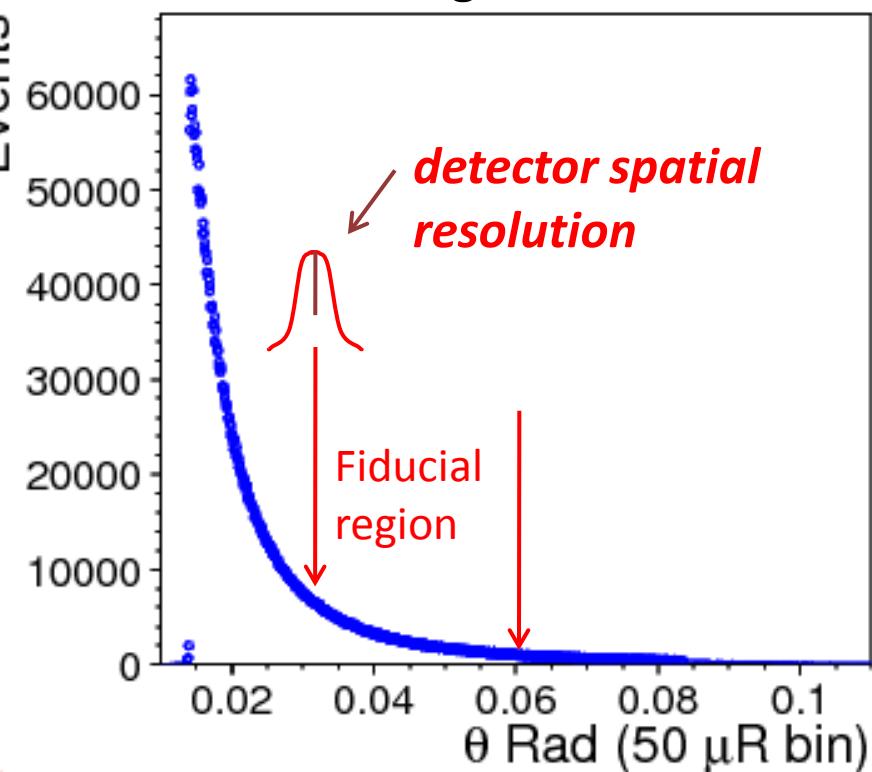
$$\rightarrow 0.1 \text{ mm on } z \text{ or } dr = \delta R x \theta = 3 \mu\text{m}$$

LumiDET design goal:

- Spatial res. narrow
- mean on $\theta_{min} < 1$ mRad



Bhabha ϑ -angle distribution



offset of
the mean on θ_{min}
 \rightarrow LUMINOSITY error

Bhabha detection

- $e^+e^- \rightarrow e^+e^-$ elastics scattering

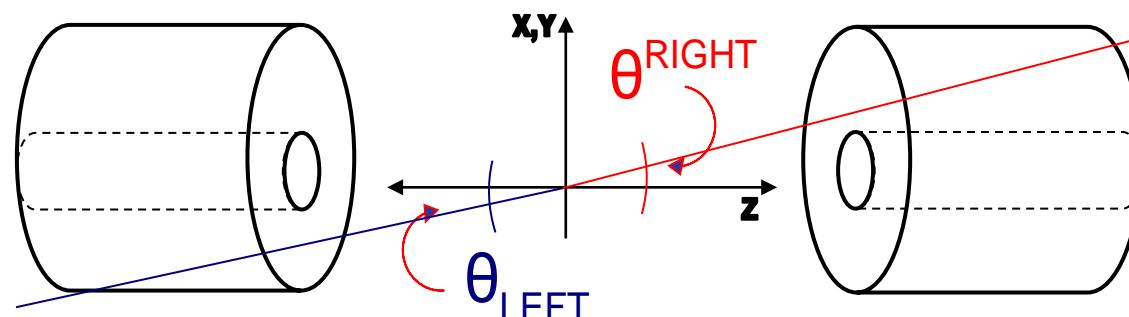
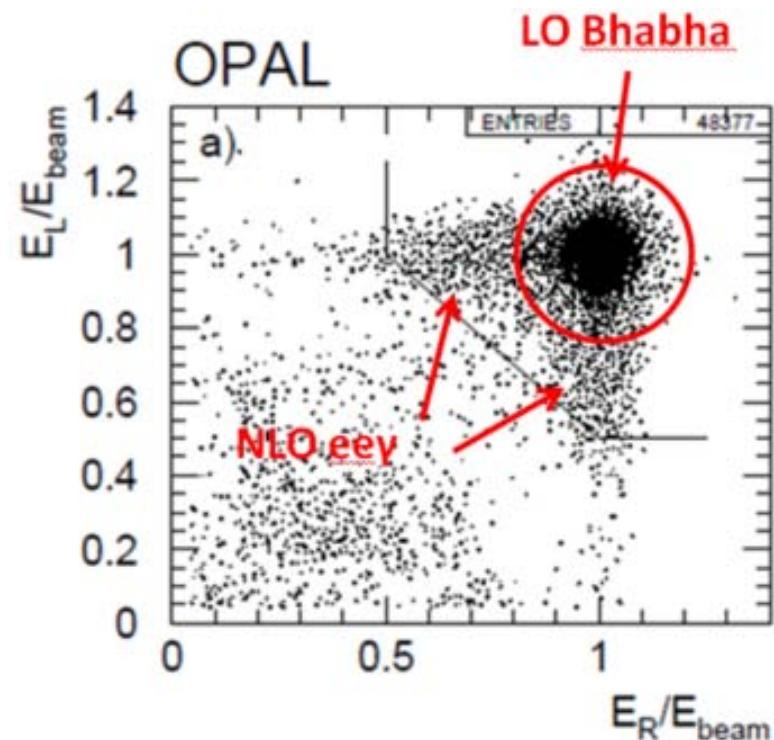
Event signature

1. $E(e^\pm) = E_{\text{beam}}$
2. e^+, e^- Back-to-Back

- **NLO** $e^+e^- \rightarrow e^+e^-\gamma$

~1% events

1. e^+, e^- approximately Back-to-Back
2. one electron $E' < E_{\text{beam}}$
3. Detector e/γ ID, spatial resolution



$$\Delta\theta \equiv \theta_{\text{RIGHT}} - \theta_{\text{LEFT}}$$

Study with BHLUMI

- scattered e γ distribution
- cross section
- 33 mRad beam crossing
→ boosted e γ distribution

BHLUMI theoretical precision

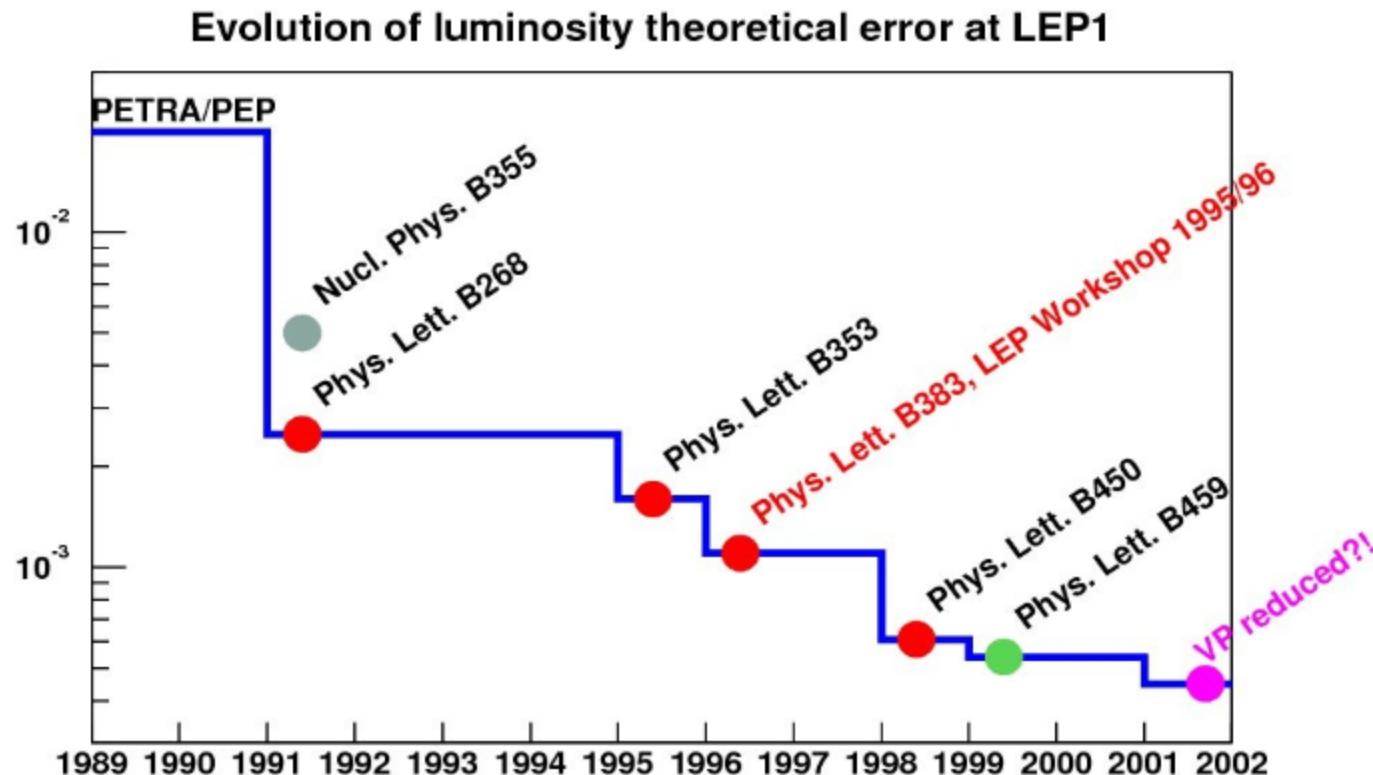
Bhlumi 4.04 writeup: CERN-TH/96-158

cds.cern.ch/record/310621/files/th-96-158.ps.gz

http://cern.ch/~jadach/public/Bhlumi-linux-4.04-export_2002.11.05.tar.gz

Theory uncertainty: 0.25% was **BHLUMI 2**, reported in CPC package paper
<http://inspirehep.net/record/321226?ln=en>

The latest **BHLUMI 4** report is pushed to < 0.1%



BHLUMI calculations

1. Theta range input : **Th1, Th2**

Xcru calculated for $\text{Thmin}=0.7 \times \text{Th1}$ to $2 \times \text{Th2}$

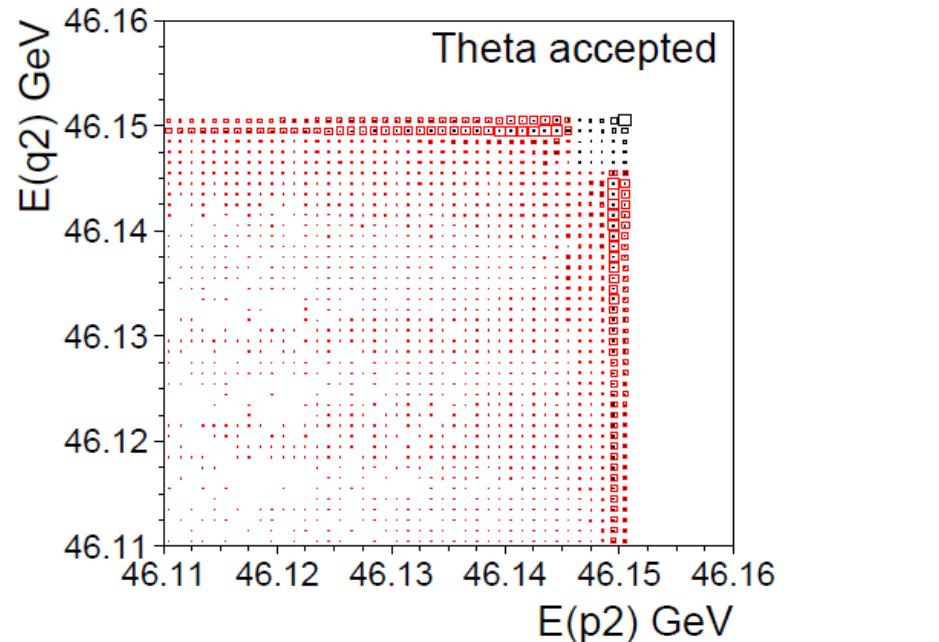
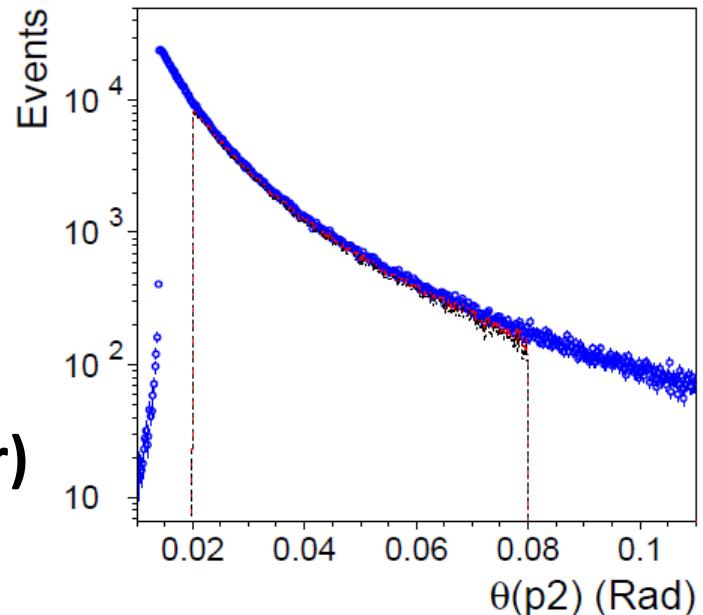
2. KeyWgt=0 → event wgt=1, for simulation
count events in chosen condition
scale to Xcru

BARE1 X section: (of the bhlumi paper)

$\text{Th1} < \theta_1' \text{ and } \theta_2' < \text{Th2}, s' > 0.5s$

Use BARE1 as reference

Having photon (red)
or not at m_z
→ 5 MeV precision



Reproduce BHLUMI to 0.1%

Bhlumi-linux-4.04-export_2002.11.05.tar.gz

Compiled by g77 on SL6, **demo.f** produce numbers as in paper

CERN-TH/96-158

BARE1: $.024 < \theta_1', \theta_2' < .058$
 $s' > 0.5s$

```
0.1000 0.252000E+03 *****  
||||| Xsec_BARE1 = 169.19520371 Nanob.  
||| error = 0.67481969 Nanob.  
||| Xsec_CAL02 = 136.21881786 Nanob.  
||| error = 0.64151939 Nanob.  
||||| suen@benji034:~/work/bhlumi/cenc/demo$
```

LEP workshop95 on Bhabha established 0.1% precision

Hep-ph/9602393

demo.f

1000000 ev

KeyPia=0, KeyZet=0

CMS = 92.3 GeV

Xsec_BARE1 = **162.5295** Nanob.

Error = 0.2061 Nanob.

```
||||| User should cross-check the following two output cross sections  
which are calculated and printed at the very end of the output:  
Workshop95, Table14, BARE1 WW for zmin=0.5: KeyGen=3, KeyPia=0, KeyZet=0  
Workshop95, Table18, CAL02 WW for zmin=0.5: KeyGen=3, KeyPia=2, KeyZet=1  
|||||
```

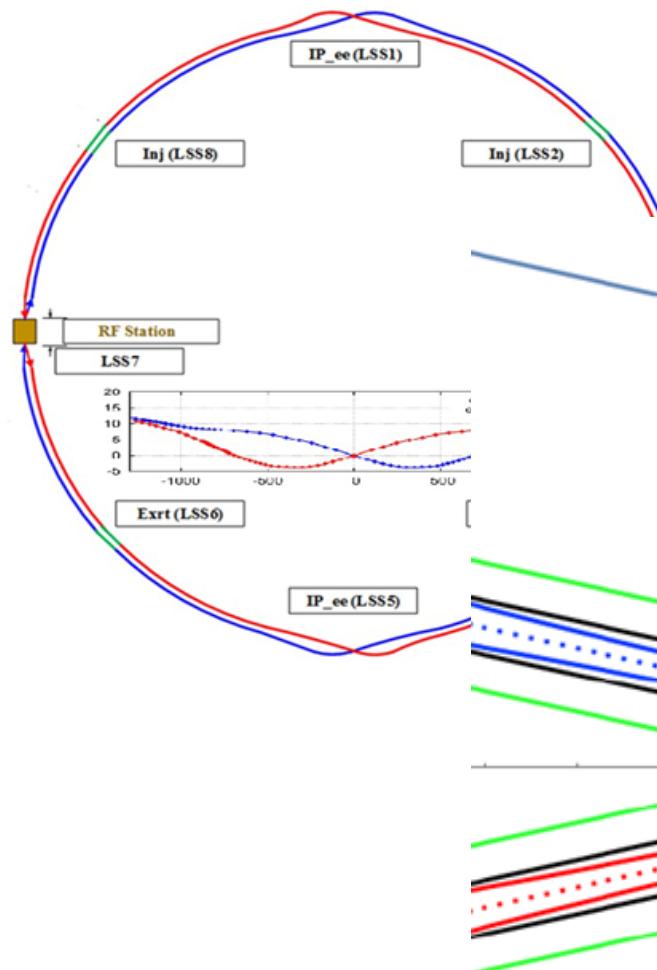
Table 14: Monte Carlo results for the symmetric Wide-Wide ES's BARE1, for matrix elements beyond first order. Z exchange, up-down interference switched off. The center of mass energy is $\sqrt{s} = 92.3$ GeV. Not available x

Hep-ph/9602393

z_{min}	BHLUMI [nb]
.100	$166.892 \pm .006$
.300	$165.374 \pm .006$
.500	$162.530 \pm .006$
.700	$155.668 \pm .006$
.900	$137.342 \pm .006$

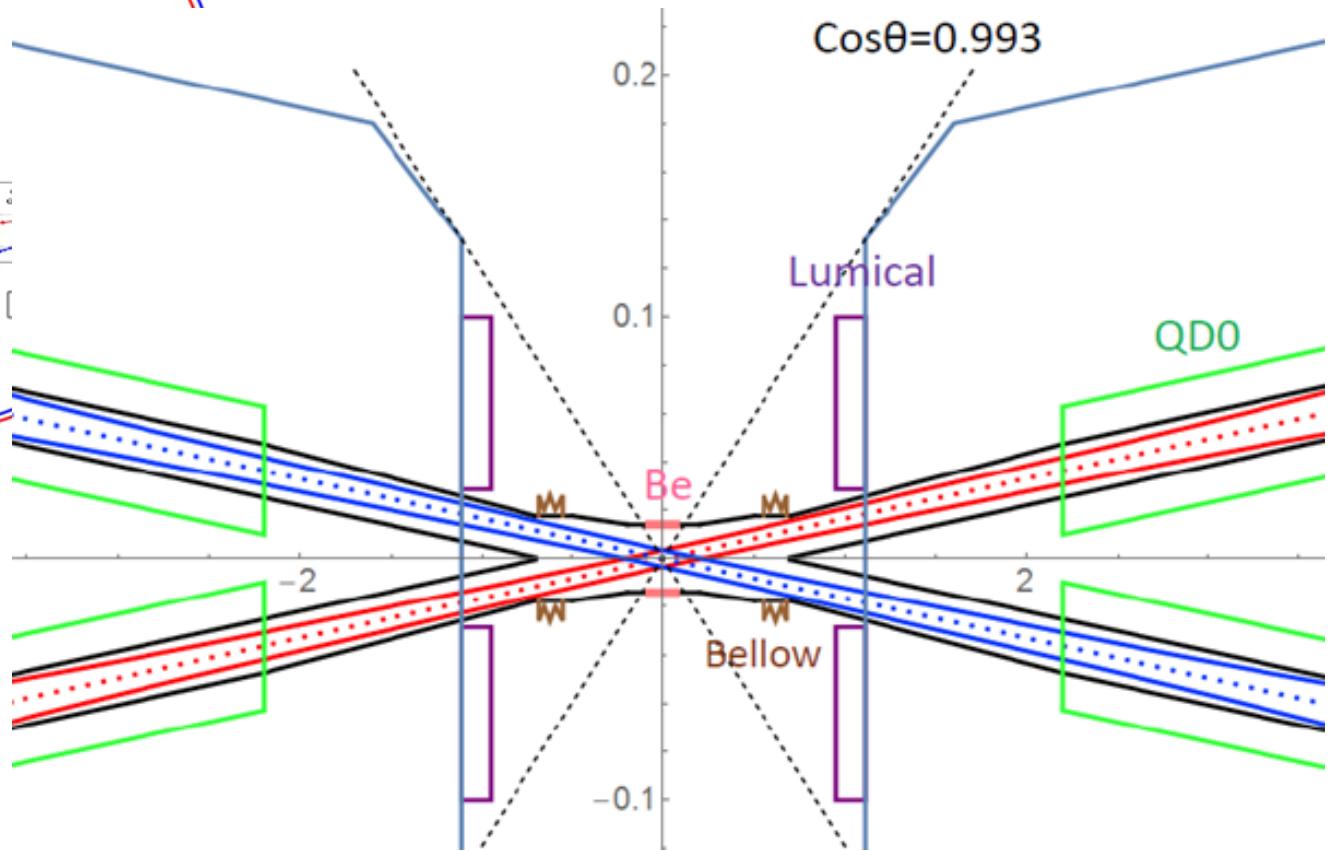
CEPC beam crossing

CEPC double Ring



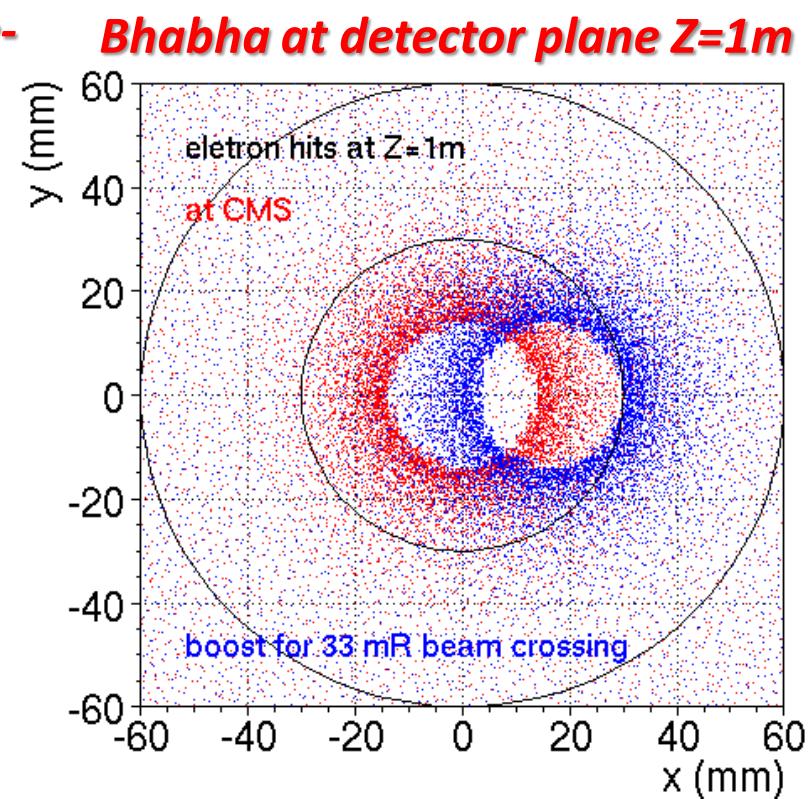
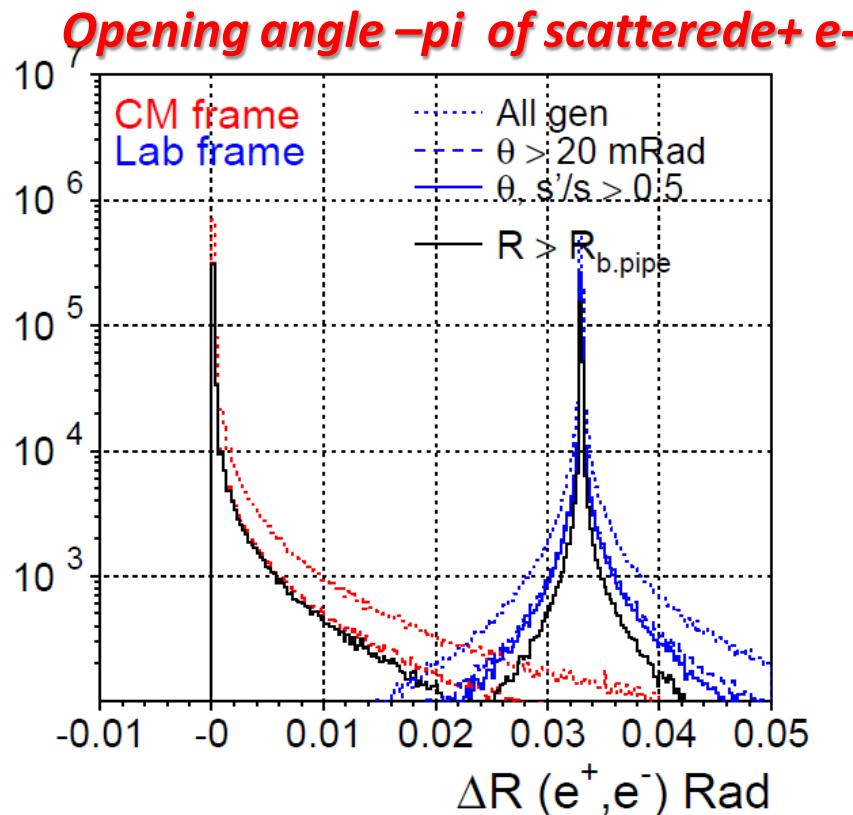
Beam crossing 33 mRad

Focal length:
 $L^* 1.5\text{m} \rightarrow 2.2\text{ m}$



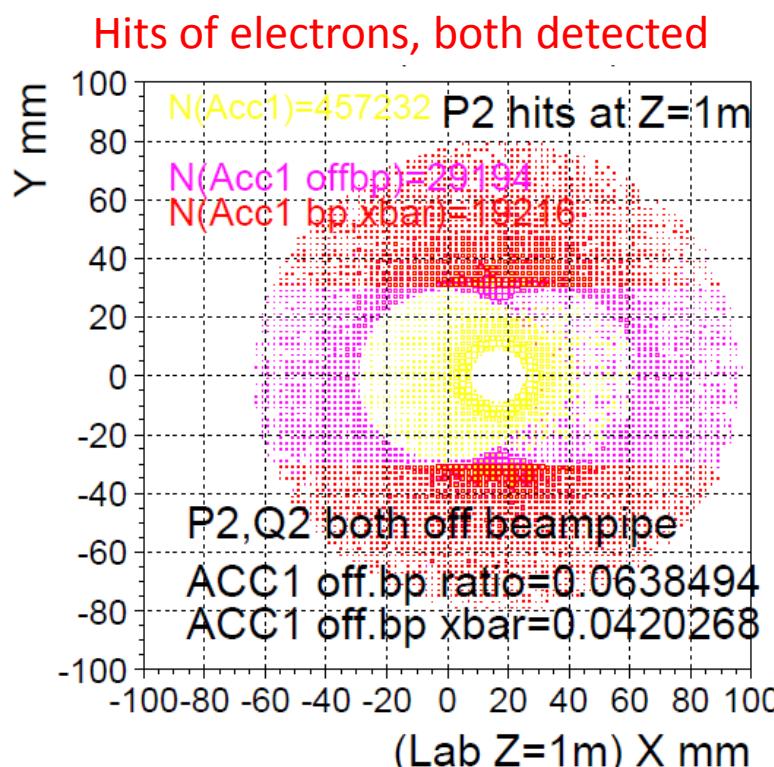
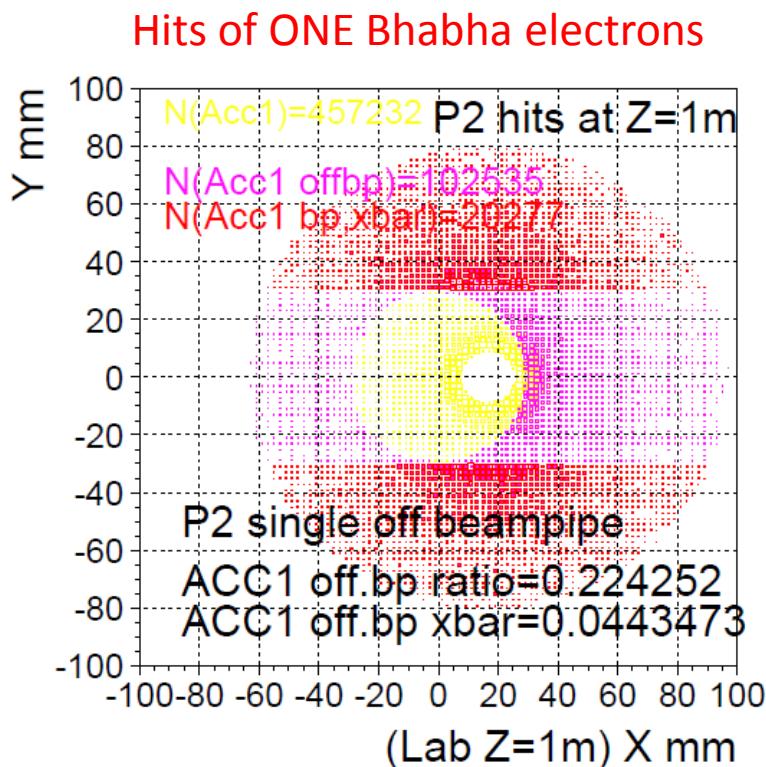
Bhabha back-to-back boosted by 33 mRad beam crossing

- Bhlumi electrons boosted for the 33 beam crossing by ~ 16.5 mRad to $+x$ direction
- Compared for Bhabha selection conditions

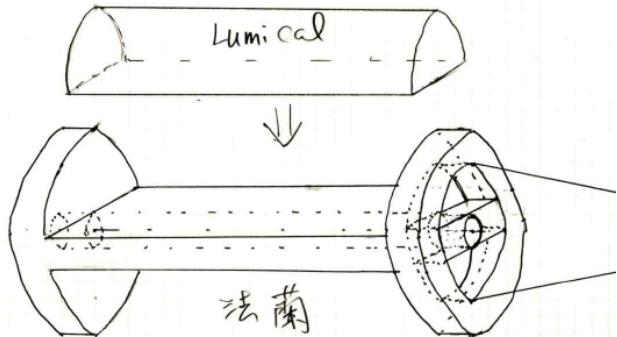


Bhabha X sec. vs Lab z-axis round pipe

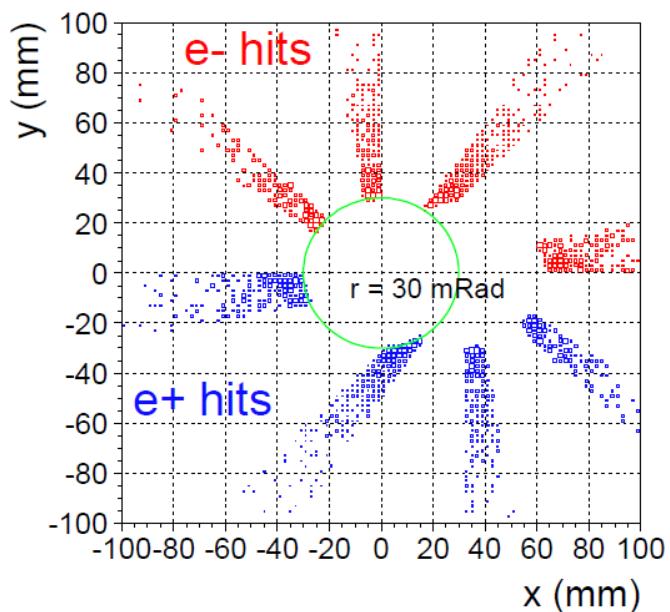
- CMS generated th1=10 mRad → boosted +16.5mRad, +X are low angle Bhabha
 - Assuming beam pipe is LAB z-axis centered, **radius = 30 mRad** ($r=30\text{mm}$ @ $z=1\text{m}$) at $x=+30\text{ mm}$, Bhabha electrons are of $\theta=13.5\text{ mRad}$
- Off beam pipe, detect: **one electron (262 nb) / both electrons (74.6 nb) = 3.51**
 → Hori. cut +/- 30mm : **one electron (51.8 nb) / both electrons (49.1 nb) = 1.05**



Bhabha X section



Round beam pipe, $r = 30 \text{ mRad}$



CMS 10 ~ 80 mRad		LAB detect ONE electron		LAB detect both electrons	
BARE1		off beampipe full phi coverage	off beampipe cut off $\pm 30\text{mm}$	off beampipe full phi coverage	off beampipe cut off $\pm 30 \text{ mm}$
Nevents	457232	102535	20277	29194	19216
Xsec (nb)	1168.3	262.0	51.81	74.60	49.10

-2 mRad in radius ($r=28 \text{ mRad}$) → 20% increase in X section

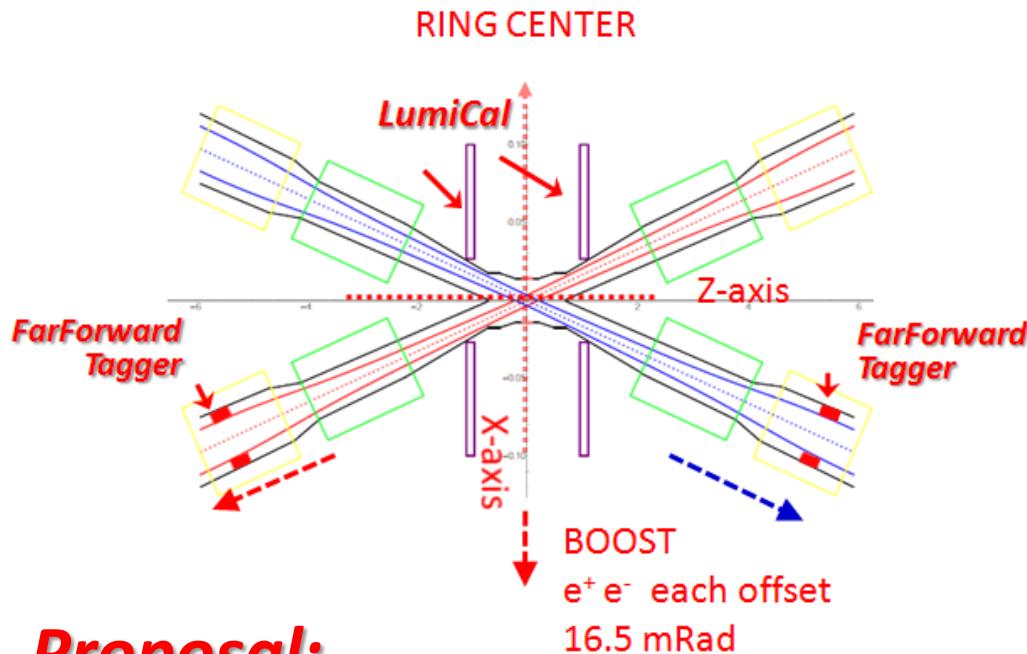
CMS 10 ~ 80 mRad		LAB ONE electron		LAB both electrons	
BARE1		off beampipe full phi coverage	off beampipe cut off $\pm 30\text{mm}$	off beampipe full phi coverage	off beampipe cut off $\pm 30\text{mm}$
Nevents	457232	135842	24236	34847	23010
Xsec (nb)	1168.3	347.1	61.93	89.04	58.80

Bhabha ONE electron detection w. Far Forward Tagger

Beam crossing: 33 mRad

→ Boost off ring center (+x axis)

→ offset 16.5 mRad maximum
(electrons on x-z plane)



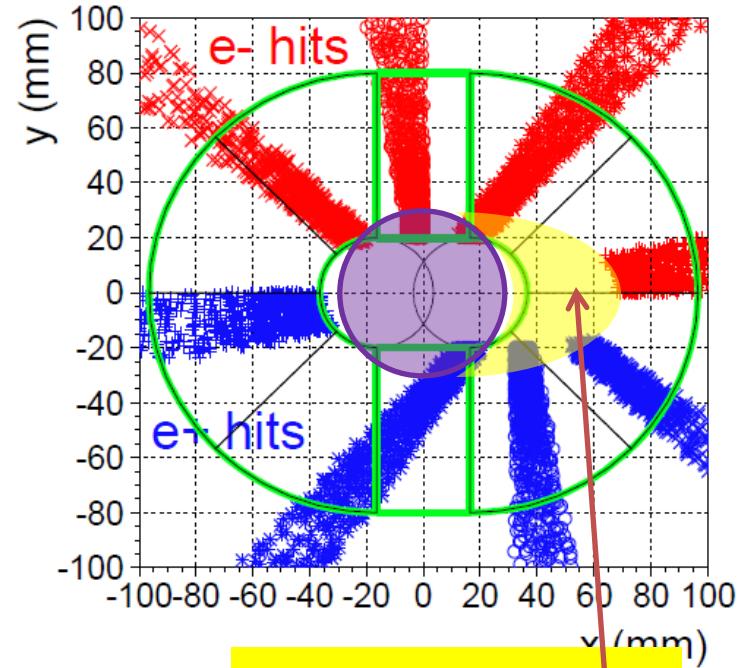
Proposal:

Far Forward Tagger on outgoing pipe

→ trigger/back-to-back of low angle electrons

→ < 50 mRad on x-axis lost into beam pipe

LOW angle Bhabha on x-axis
one electron detected (+x side)
the other electron (-x side)
is boosted into beampipe
NOT counted for Lumi measurement



BHLUMI study summary

- 33 mRad boost to +x direction
Lab frame asymmetrical coverage
- Bhabha $\Theta_{\min} \sim 30$ mRad for ~ 50 nb
having both back-to-back electrons detected
- An OVAL shape Beampipe
space to LumiDET in y → gain to Bhabha
- F.F tagger to trigger Bhabha
w. one electron in LumiCal fiducial region

LumiCal in MDI region

Lumi Si wafers before/behind Flange

1st impact Si-wafer <5 um

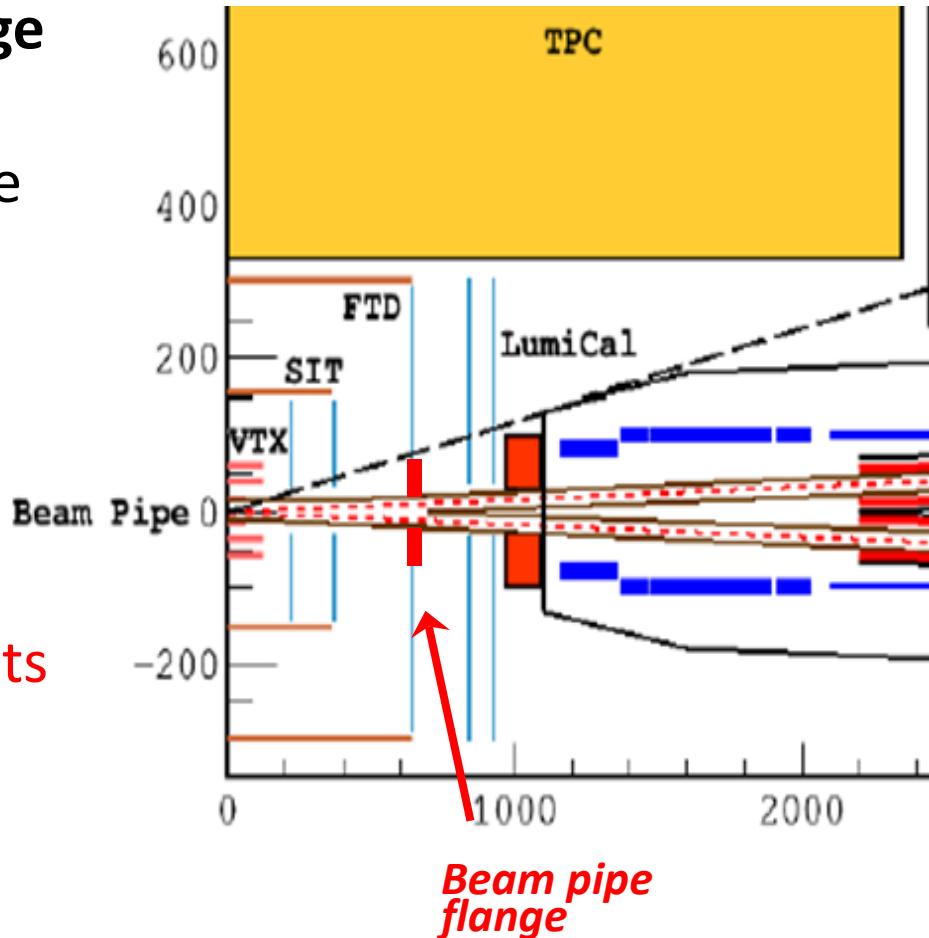
Tracker/preshower layers in flange
for Bhabha ID, e/γ separation

LumiCal on Quadruple @ $z \sim \pm 1$ m

Bhabha electron shower energy

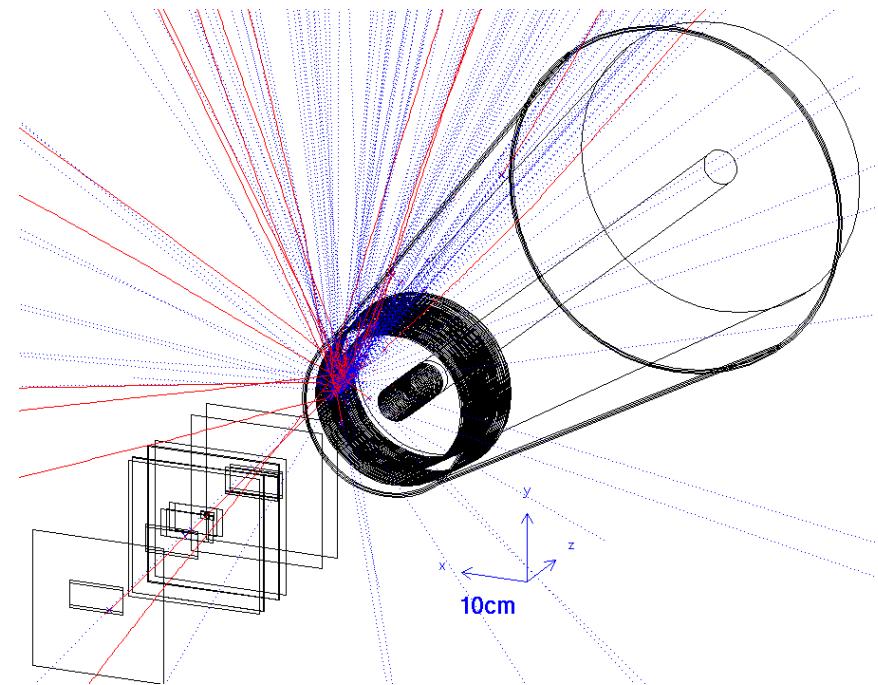
GEANT studies

- Spatial resolution of electron hits
- Shower leakage to TPC
- tracking volume (z to ± 2 m)



GEANT simulation for spatial resolution

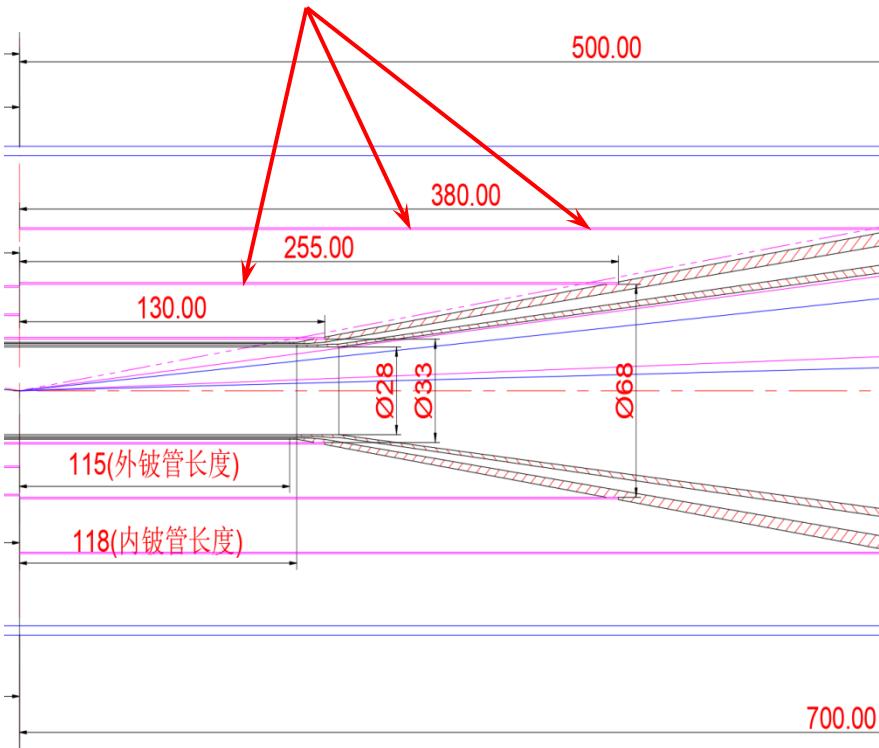
- A package used for test-beam Si calorimetry study
 - lateral shower spectrum agree with data
- LumiCal in CDR: a SiW sandwich detector
 - no upstream material
- post-CDR: a Cone shape beam pipe
 - best spatial resolution
- **tube shape beam-pipe**
 - spatial resolution w. Octagon Si wafers surrounding beampipe



New Beam pipe is LAB centered

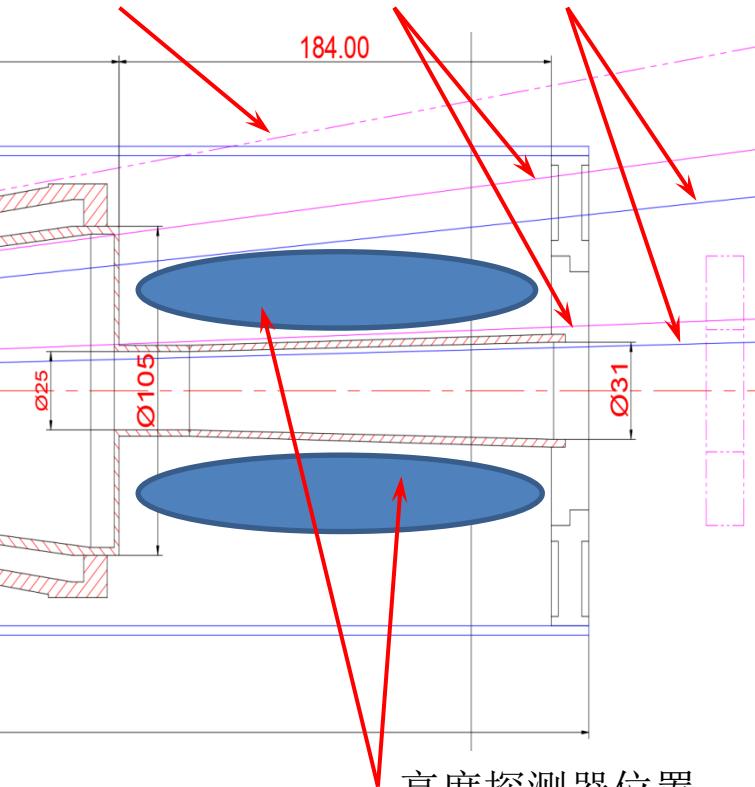
束流管内方案

顶点探测器位置



内镀管厚度: 0.50
 外皮管厚度: 0.35
 内外镀管间隙: 0.5
 冷却介质: 1号电火花油

$\text{Arccos}(0.99)(30 \sim 100)\text{mrad}$ ($20 \sim 80$) mrad



亮度探测器位置

说明:

1. $\varnothing 25$ 和 $\varnothing 31$ 是根据白莎的计算, 最小束流管孔径
2. 亮度探测器对应管道为单层管(无冷却),
需根据计算确定184mm 是否满足温度要求

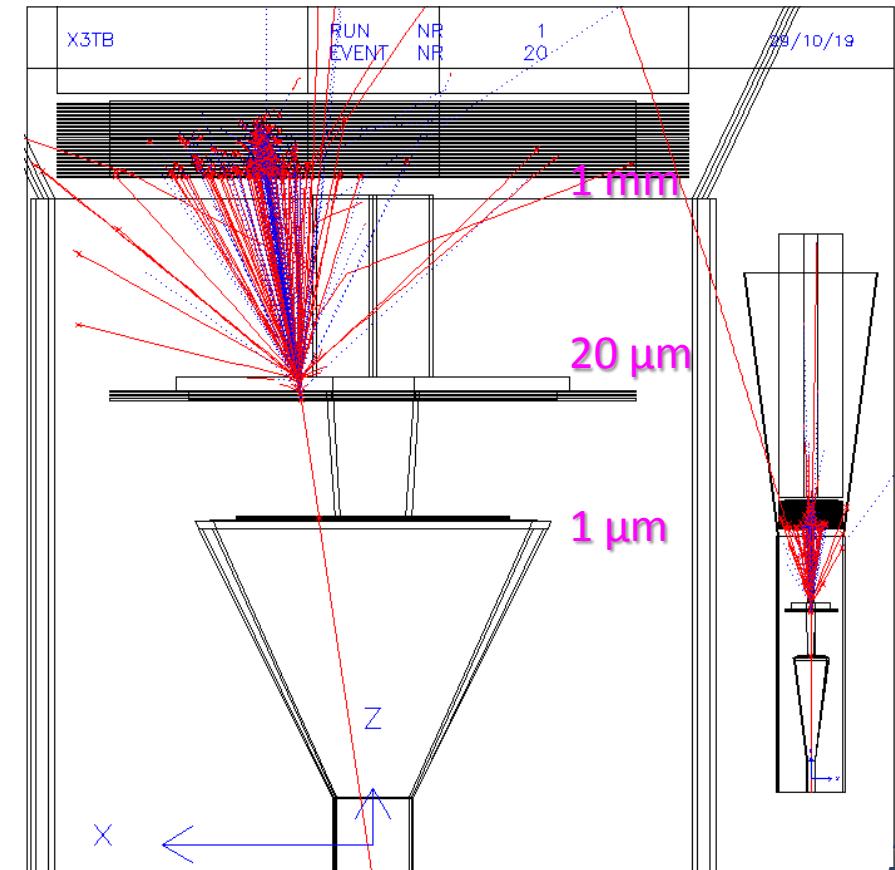
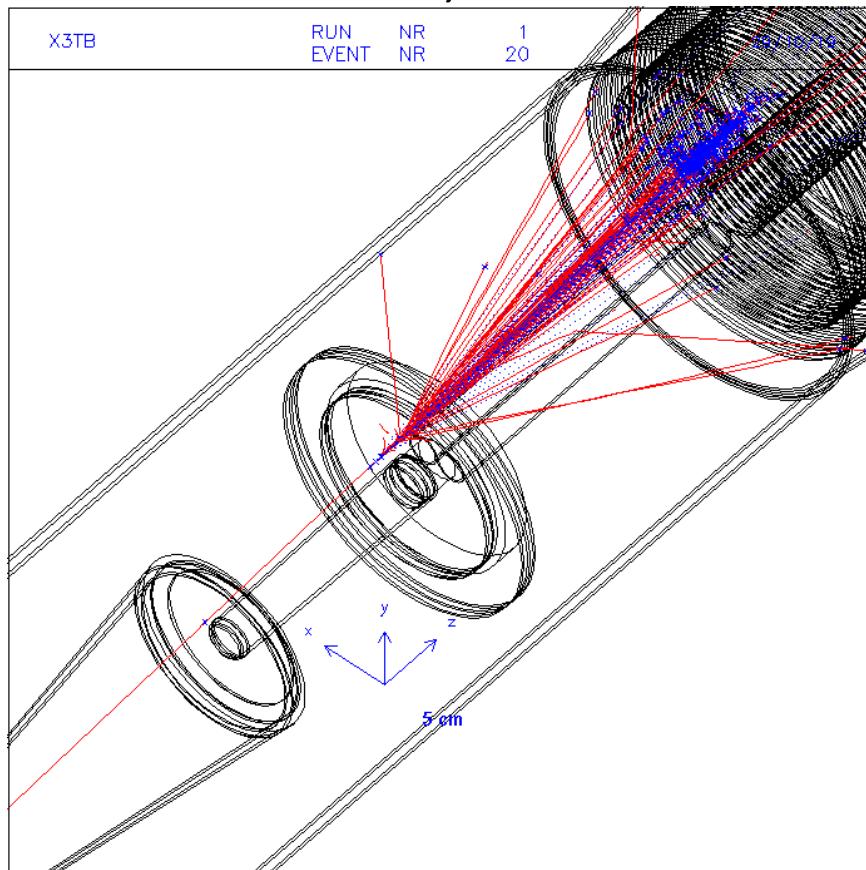
Precision on electron impact position

GEANT simulation precision is 0.1 MeV

Si wafer behind beam-pipe cone face, whatever material thickness,
Impact position is not effected by multiple scattering/fragmentation

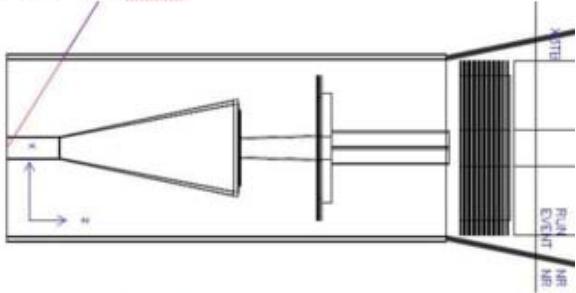
→ Better than 1 μm

50 GeV electron, shoot LumCal center theta = 40 mRad

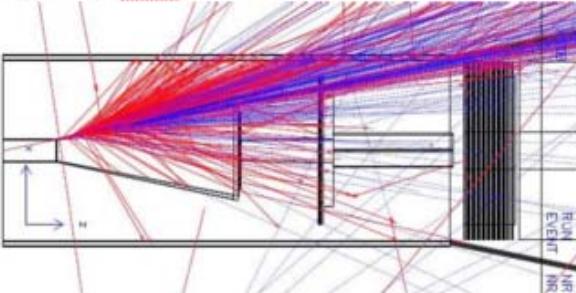


50 GeV electron shower vs. angle

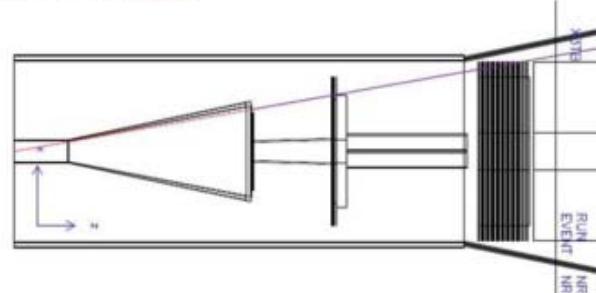
Angle = 785 mRad.



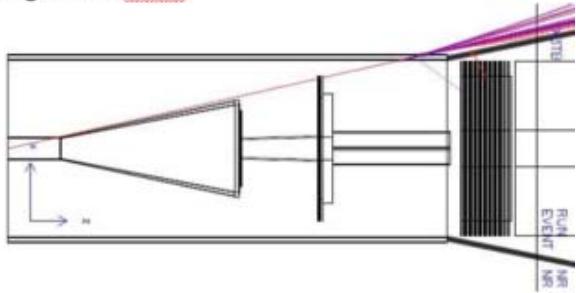
Angle = 130 mRad.



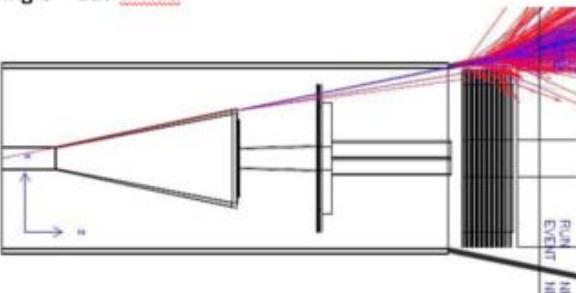
Angle = 110 mRad.



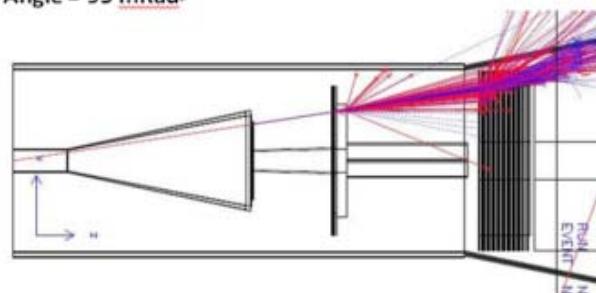
Angle = 140 mRad.



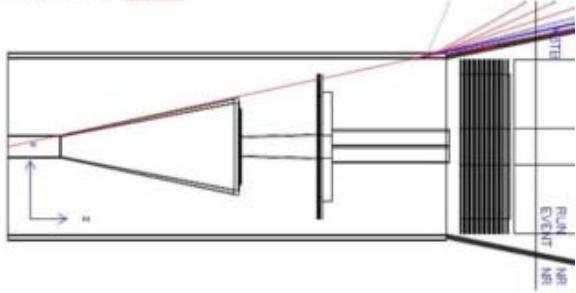
Angle = 127 mRad.



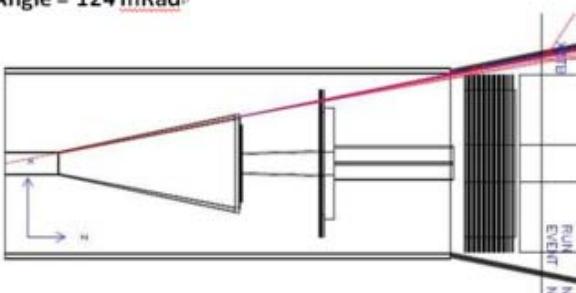
Angle = 95 mRad.



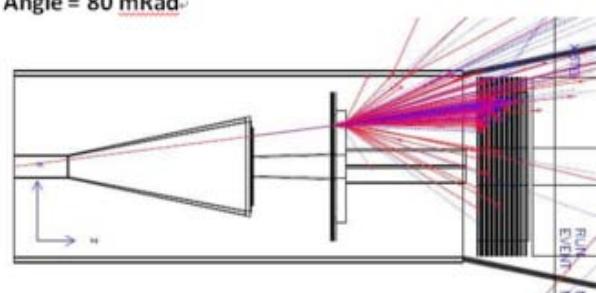
Angle = 135 mRad.



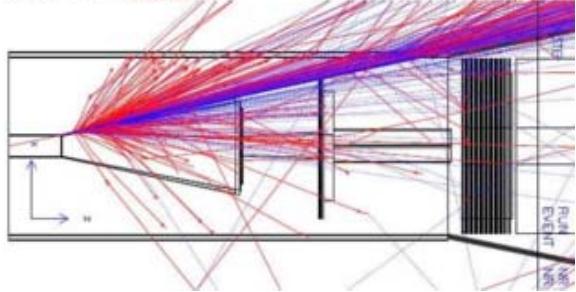
Angle = 124 mRad.



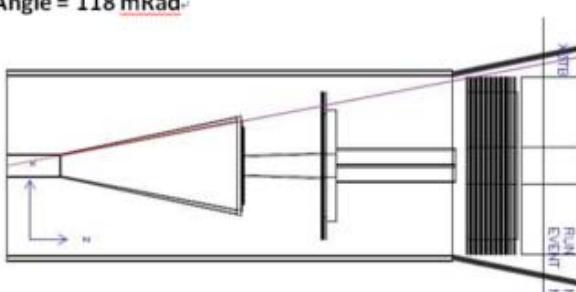
Angle = 80 mRad.



Angle = 132 mRad.



Angle = 118 mRad.

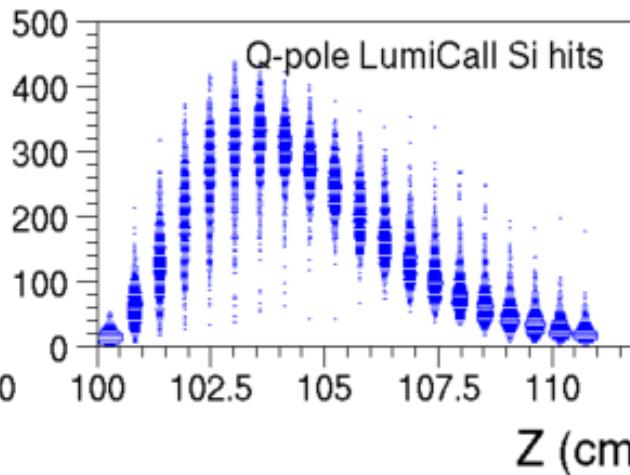
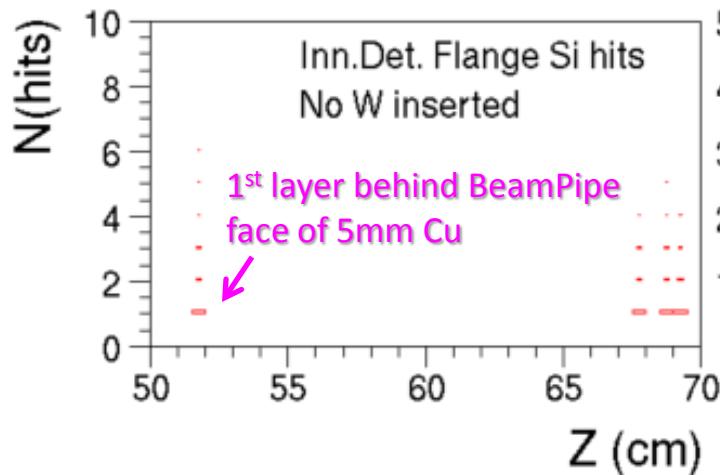


Precision on electron impact position

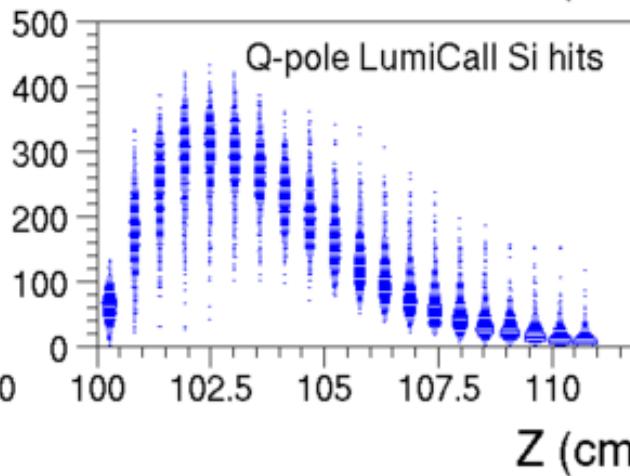
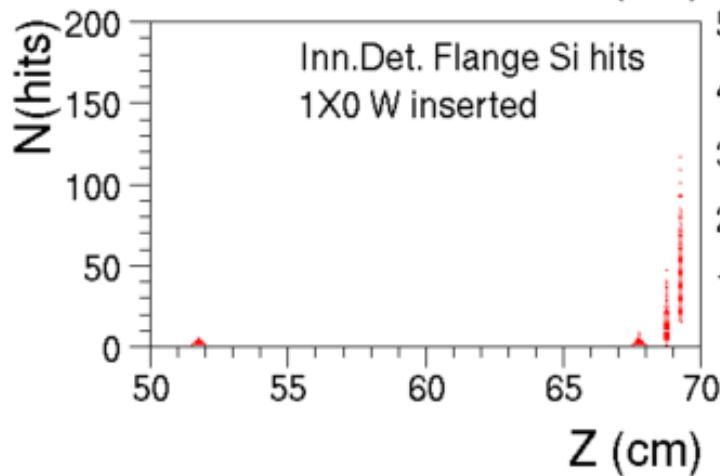
Compare Flange having two 1X0 Tungsten layers OR NOT

GEANT particles of 0.1MeV

Hits of shower secondaries on Si layers

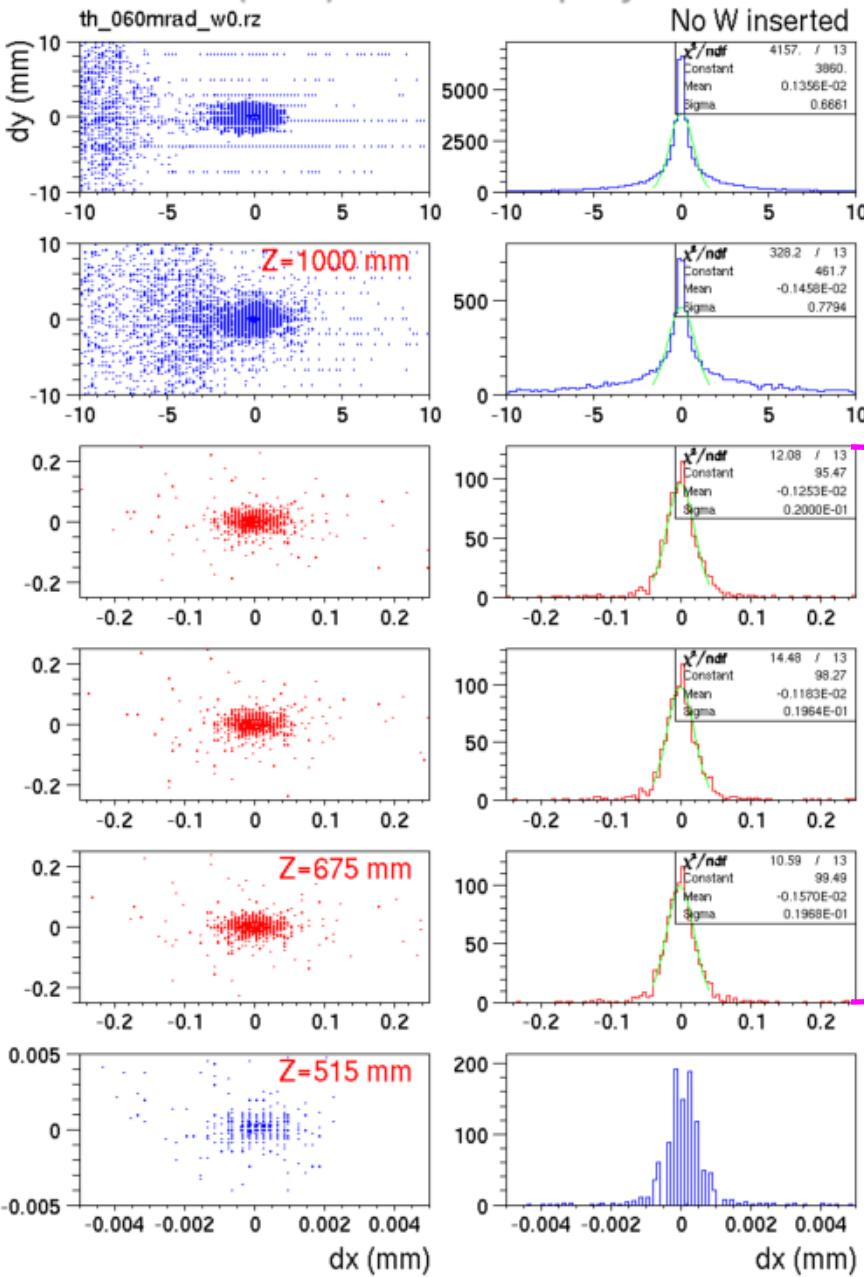


← Flange has
NO Tungsten layers



← Flange has 1X0
2 Tungsten layers

Position(Hits) – Electron projected



Spatial Resolution of piled up hits (50 GeV electrons)

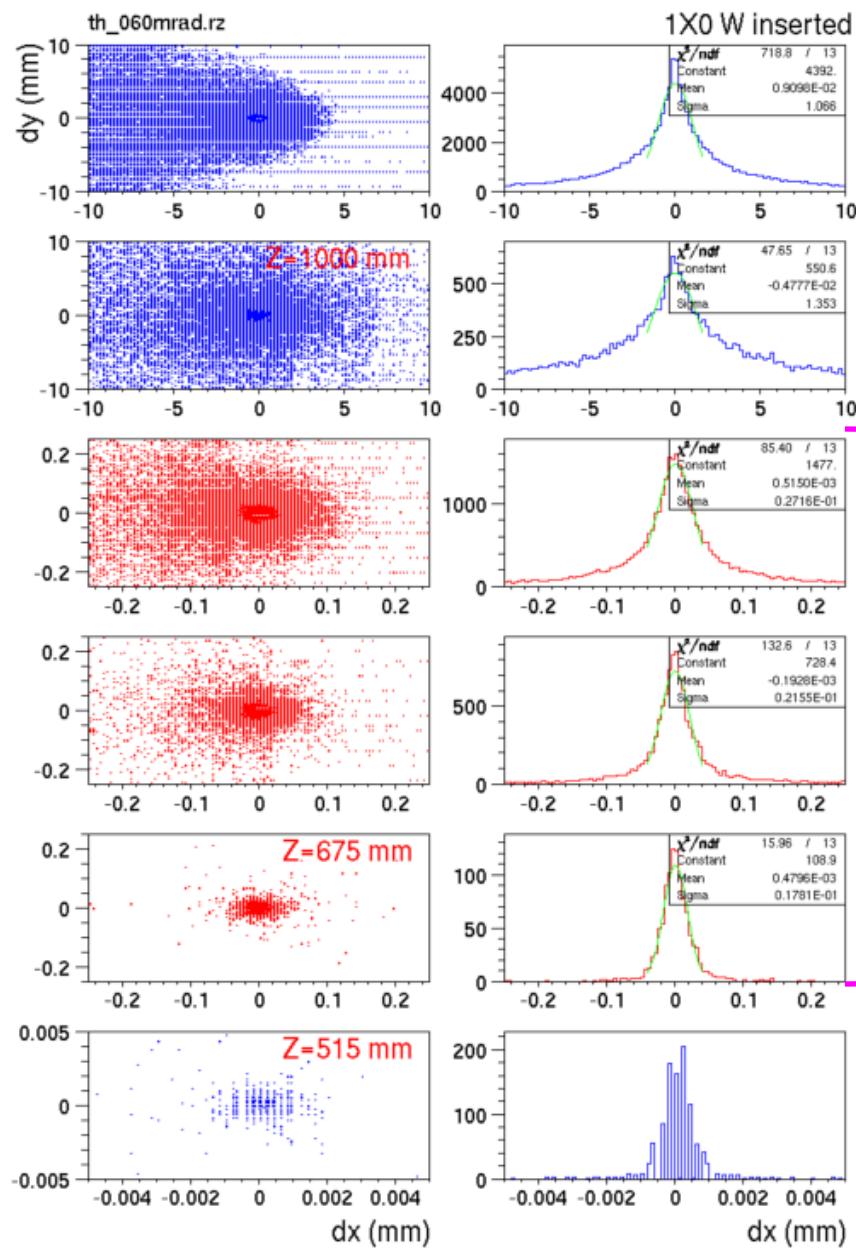
Front 2 Si-layers of Q-pole LumiCal
Pileup of shower ~1 mm resolution

Three Si layers at $Z > 670$ mm
NO Tungsten layers
Spatial resolution $\sim 20 \mu\text{m}$

1st Si layer behind Beampipe cone at $Z = 515$ mm
Hit deviation better than $1 \mu\text{m}$

Spatial Resolution of piled up hits (50 GeV electrons)

Position(Hits) – Electron projected



Front 2 Si-layers of Q-pole LumiCal
Pileup of shower ~1 mm resolution

Three Si layers at $Z>670$ mm
Two 1X0 Tungsten layers behind Si wafers
Spatial resolution ~ 20 μm

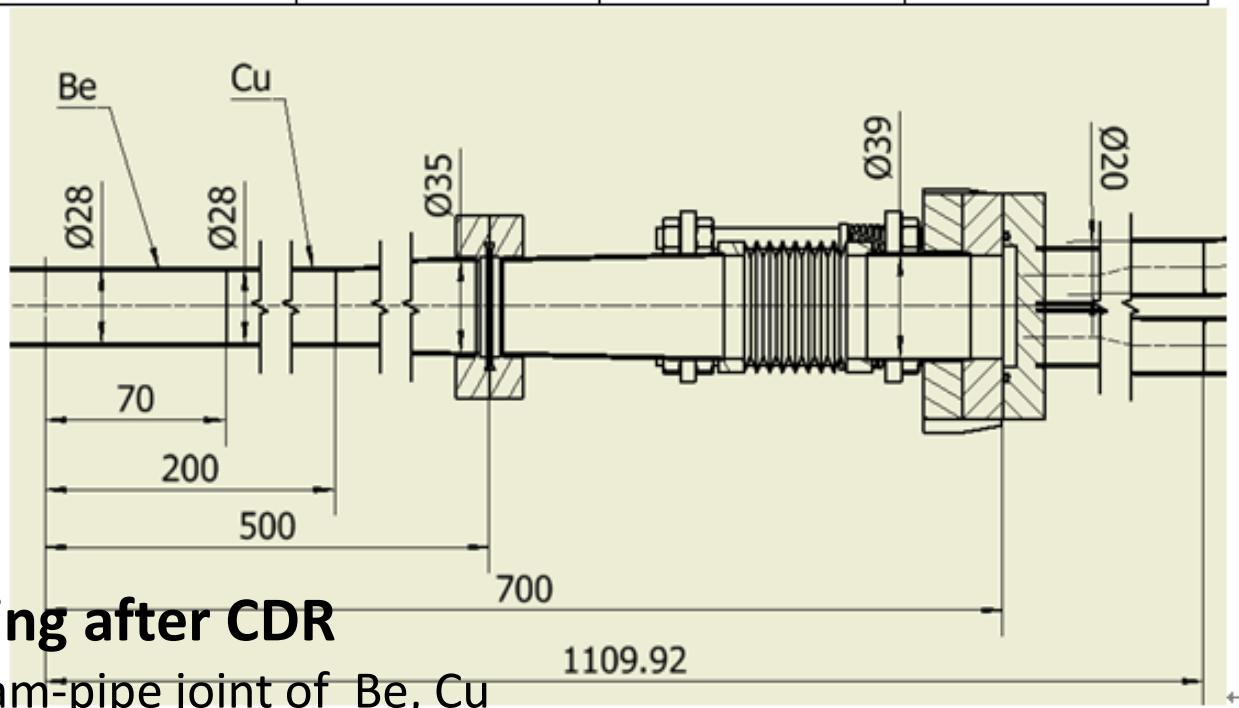
1st Si layer behind Beampipe cone at $Z=515$ mm
Hit deviation better than 1 μm

Beampipe post-CDR

1. Be 的長度為 140mm，Z 軸圈-70~70mm。

2. 以 IP 單側為例，Be 管及銅管的尺寸見下表及附圖，真空管相對於 IP 對稱。

材料	Z範圍 (mm)	內直徑 (mm)	備註
Be	0~70	28	直管
Copper	70~200	28	直管
	200~500	28~35	錐管
	500~700	35~39	錐管，包含波紋管



Beam pipe drawing after CDR

Assuming a tube beam-pipe joint of Be, Cu

Electron Traversing 2mm Cu pipe → very “THICK” in forward direction

GEANT with post-CDR beam-pipe

X3TB

RUN
EVENT
NR
NR

1
2

Material thickness

traversing 2mm thick Cu beam pipe

$$2\text{mm}/L = \tan(30 \text{ mRad}) \quad L = 33.34 \text{ mm} \sim 2.3 X_0$$

$$2\text{mm}/L = \tan(100 \text{ mRad}) \quad L = 10.02 \text{ mm} \sim 0.7 X_0$$

At Z=50cm passing 1mm Cu $\sim 1X_0$ material

Radiation length

<http://pdg.lbl.gov/2014/AtomicNuclearProperties/>

$$X_0(\text{Be}) = 35.28 \text{ cm}$$

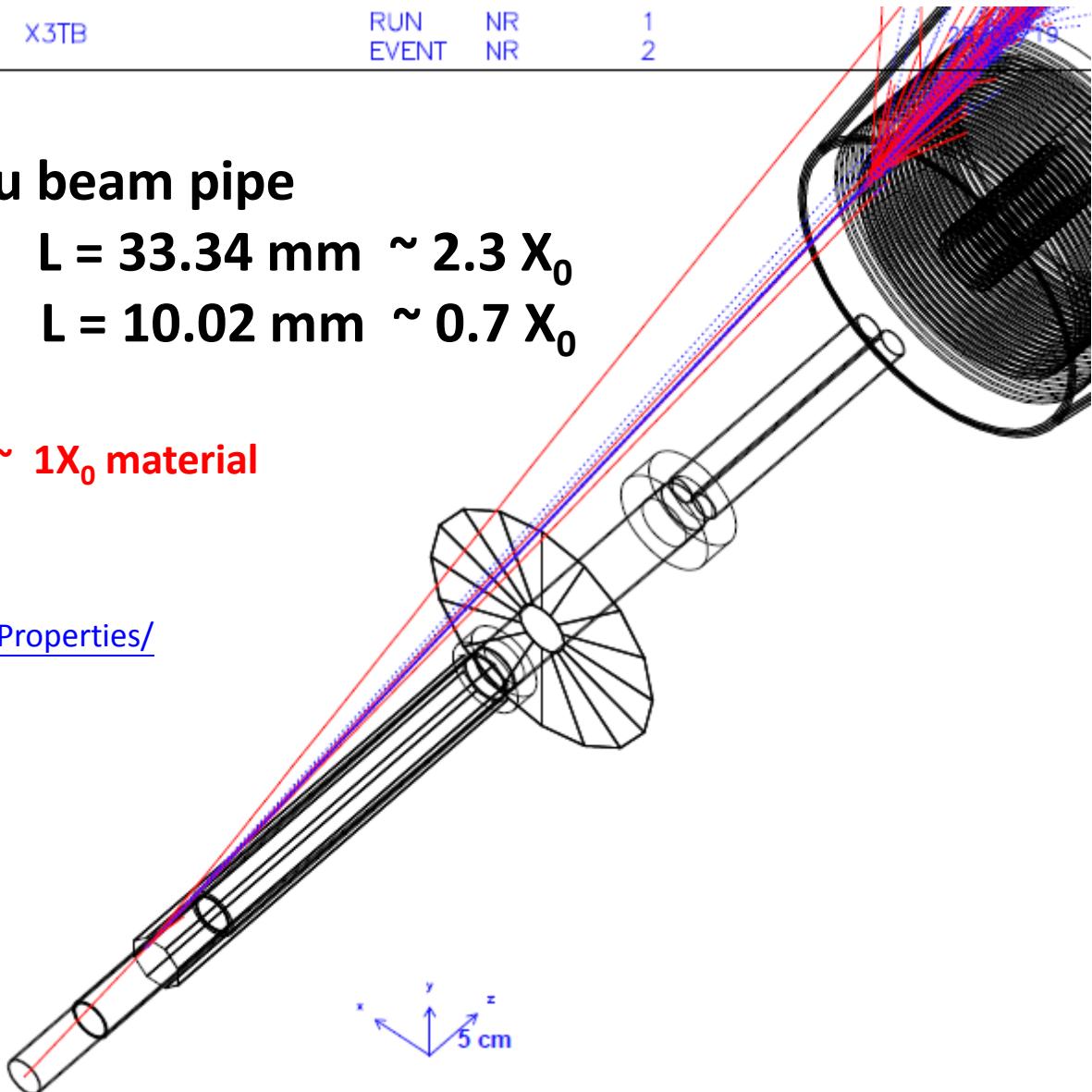
$$X_0(\text{Al}) = 8.90 \text{ cm}$$

$$X_0(\text{Si}) = 9.37 \text{ cm}$$

$$X_0(\text{Fe}) = 1.76 \text{ cm}$$

$$X_0(\text{Cu}) = 1.44 \text{ cm}$$

$$X_0(\text{W}) = 0.35 \text{ cm}$$



Flat tube beam-pipe (2020 practice)

$$\begin{aligned} \arccos(0.99) &= 141.54 \text{ mRad} @ Z=118 \rightarrow r = 16.81 \text{ mm} (= \tan Q * 118) \\ \arccos(0.992) &= 126.58 \text{ mRad} @ Z=118 \rightarrow r = 15.02 \text{ mm} \\ Q &= 100 \text{ mRad} @ Z=118 \rightarrow r = 11.84 \text{ mm} @ Z=153 \rightarrow r = 15.35 \text{ mm} \end{aligned}$$

409 TbFe 5mm Fe
Z=0~970 mm connecting to
r= 12.34cm ~+.5cm, FE

TbOS 2mm scin
Z=0~970 mm r= 12.39cm +.2cm

$$\begin{aligned} \text{Acos}(0.99) &= .14154 \text{ rad} \\ \text{Acos}(0.992) &= .1266 \text{ rad} \\ \text{atan}(123.6/970) &= .12678 \text{ rad} \end{aligned}$$

TbIS 2mm scin
Z=0~970 mm r= 12.32cm +.2cm

Fing 10mm thick flange
Z=520~530 mm
r = 55~123.2 mm

$$\text{Acos}(0.992) = .1266 \text{ rad}$$

Al dual tubes
.5mm, .35 mm thick

Fwin window 2 mm
Z=520~522
r = 15.35~55 mm

Flange

419 FLSi Si deck
Z=522~524
R = 15.5-55. mm
29.7-105 mrad

FS0i SiW two layers
Deck=3.5mmW+2mmAir
R = 15.5-70. mm
22.3-100.2 mrad @ Z=696

Fend Flange 20mm
Z=696 - 716
r = 15.5~123.2 mm

Z=115 mm
Z=118 mm

15 mm
14 mm

401 InBPipe

InBP Inner Be pipe
Z=0~118 mm,
inner diameter 28 mm 0.5mm thick

InAl Inner Al pipe
Z=118~500 mm,
inner diameter 28 mm 0.5mm thick

Fpip flange pipe 1.5 mm thick
Z= 522-716 mm
at Z=512 r = 14 – 15.5 mm

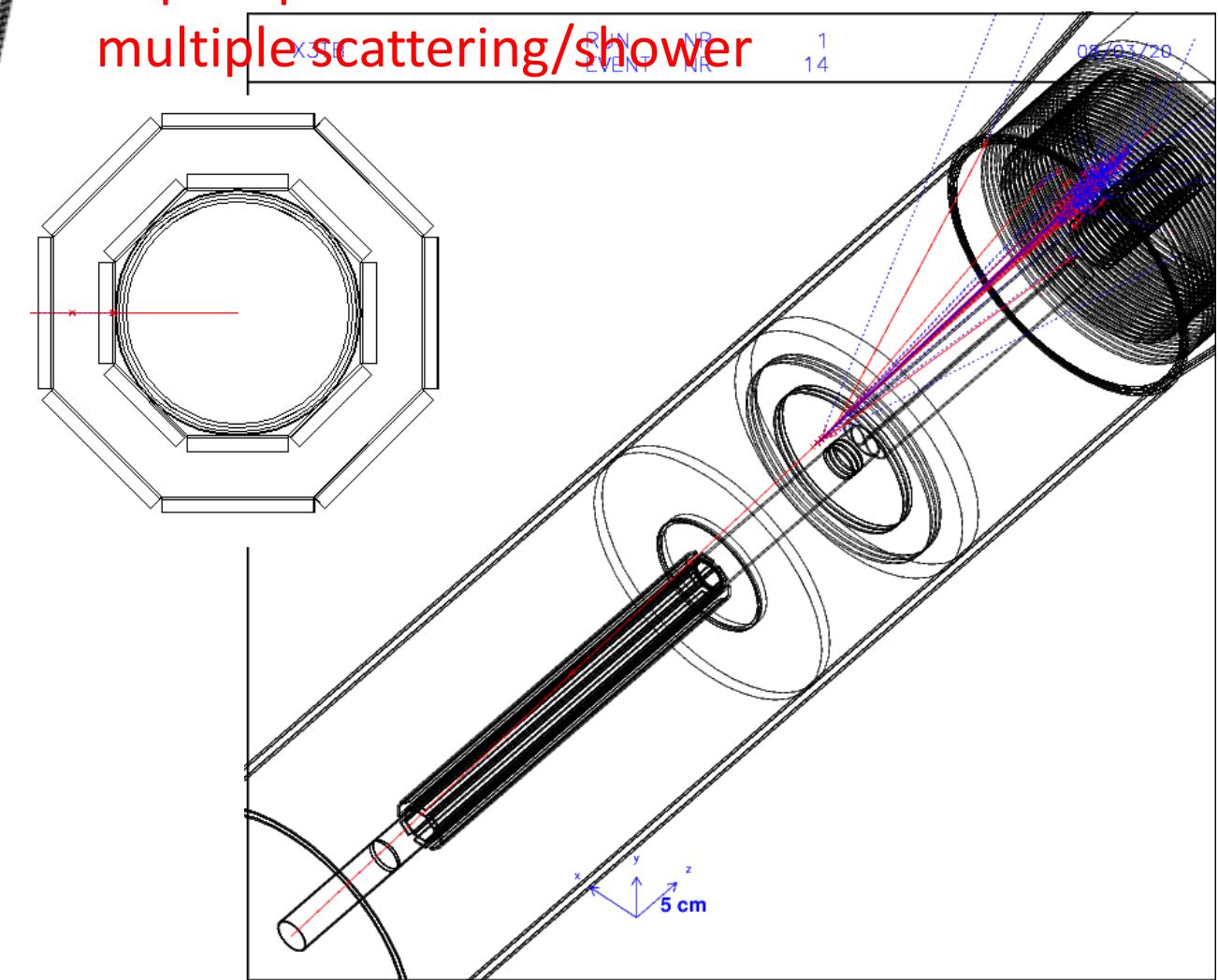
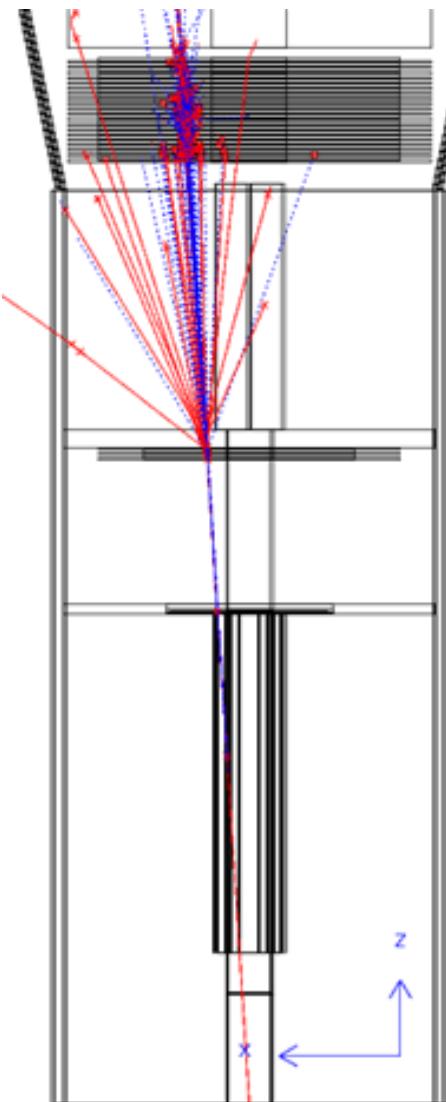
OuBP outer Be pipe
Z=0~115 mm
inner radius 28/2+1 mm 0.35mm thick

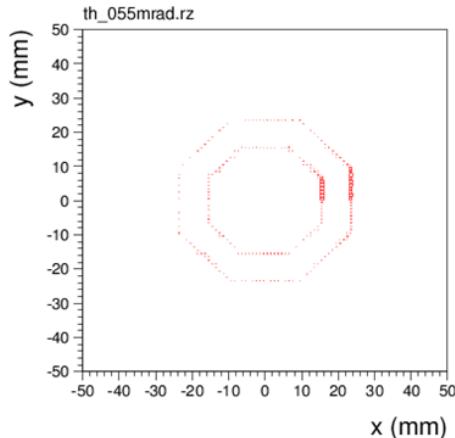
OuAl outer Al pipe
Z=0~115 mm
inner r=28/2+1 mm, 0.35 mm thick

Si octagon wafers surrounding beampipe

Si wafer attach to beampipe

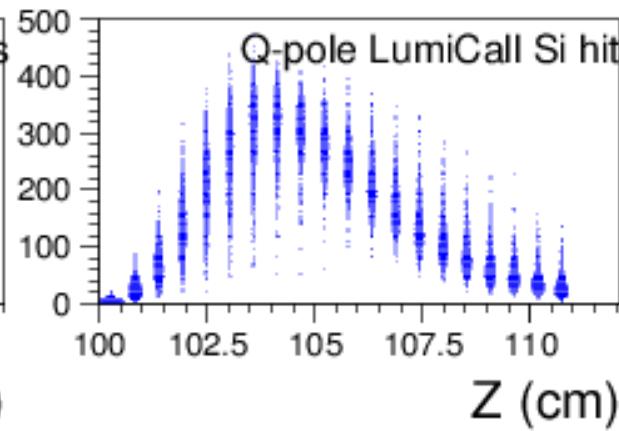
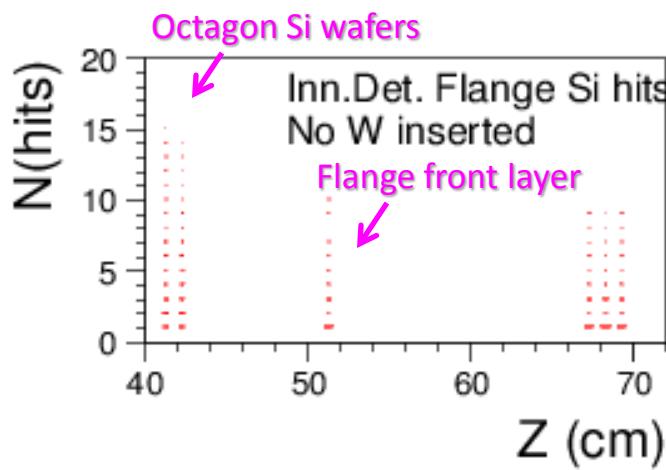
→ Impact position w. minimum effect
multiple scattering/shower



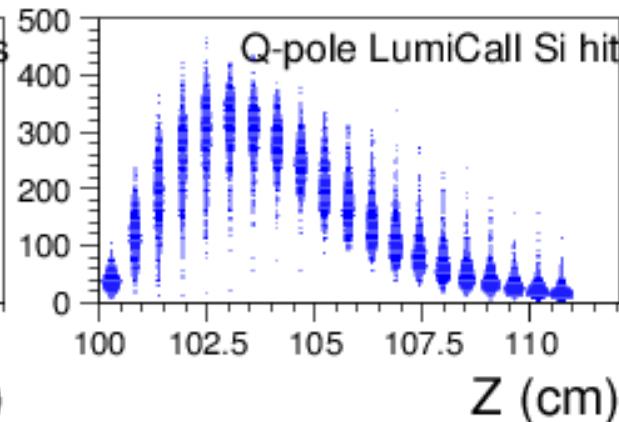
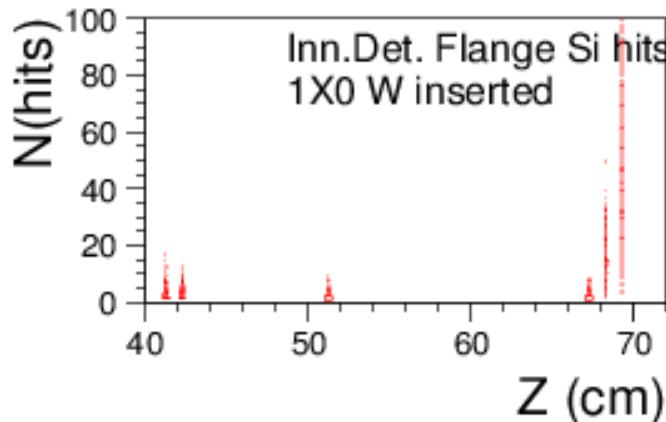


Precision on electron impact position

Hits of shower secondaries on Si layers

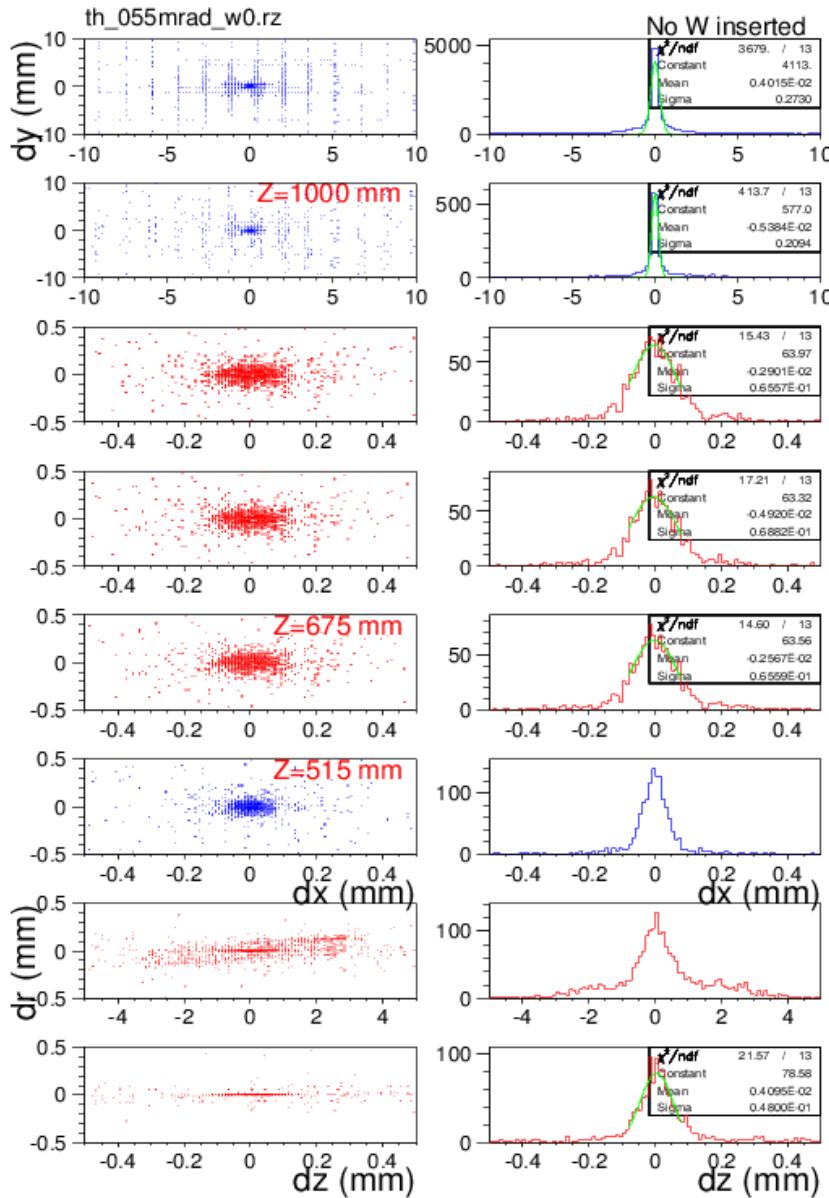


← Flange has
NO Tungsten layers



← Flange has two
1X0 Tungsten layers

Position(Hits) – Electron shower



Piled up of shower hits (50 GeV electrons)

Front 2 Si-layers of Q-pole LumiCal
Pileup of shower ~1 mm resolution

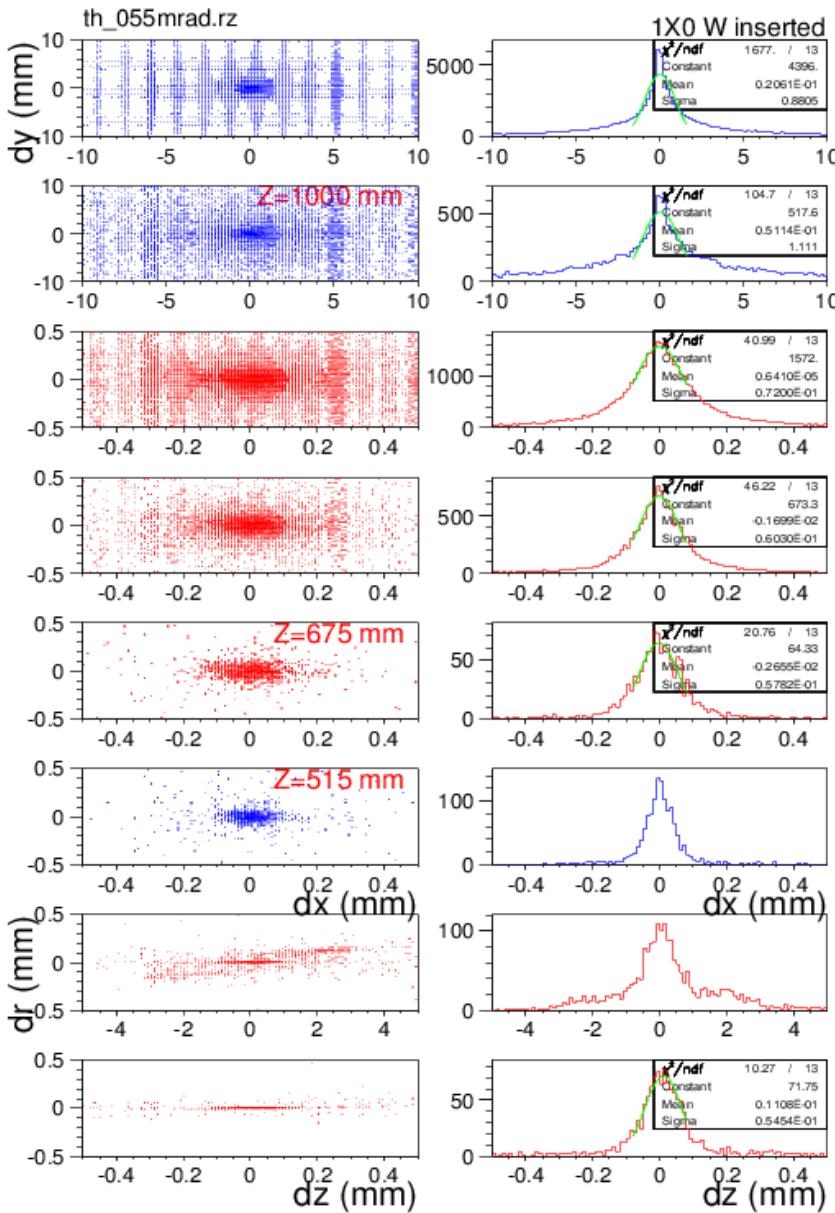
Three Si layers at $Z > 670 \text{ mm}$
NO Tungsten layers

1st Si layer behind flange at $Z = 515 \text{ mm}$

Octagon Si layers surrounding beampipe

1st layer $\sigma = 50 \mu\text{m}$

Position(Hits) – Electron shower



Piled up of shower hits (50 GeV electrons)

Front 2 Si-layers of Q-pole LumiCal
Pileup of shower ~1 mm resolution

Three Si layers at $Z > 670$ mm
Two 1X0 Tungsten layers
between Si wafers

1st Si layer behind flange at $Z = 515$ mm

Octagon Si layers surrounding beampipe

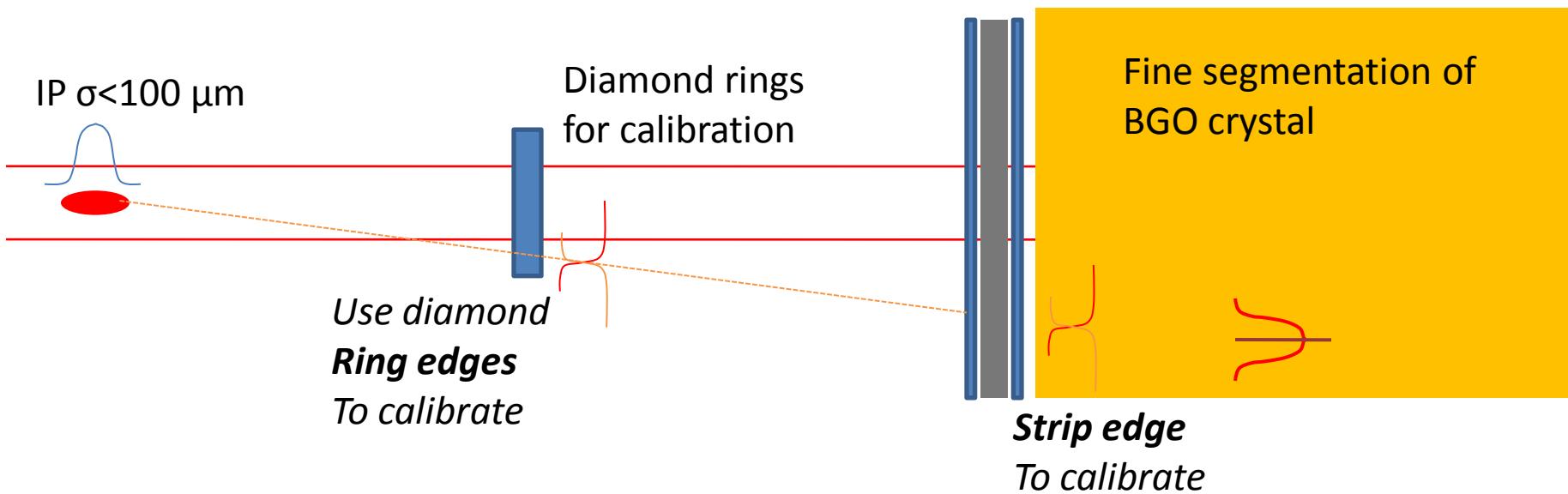
1st layer $\sigma = 55$ μm

LumiCal tracking (*CDR proposal*)

- IP + Diamond → calibrate Lumi strip position
- Diamond + LumiCal → measure IP size

Calibrate offset of the *mean of error* at inner radius

Silicon strip resolution $\sim 5 \mu\text{m}$, error on mean CAN reach $1 \mu\text{m}$,
→ $\delta L/L \sim 0.01 \%$



LumiCal tracking

for luminosity $\delta L/L = 10^{-4}$

at $z=50$ cm, $\theta = 30$ mRad $\rightarrow \delta\vartheta = .75 \mu\text{Rad}$ or $dr = .75 \mu\text{m}$

scaling to dz by $1/\tan(.030) = 33 \rightarrow dz = 25 \mu\text{m}$

Si strip, pitch in Z, 300 μm thick \rightarrow traversing distance in $z = 10$ mm

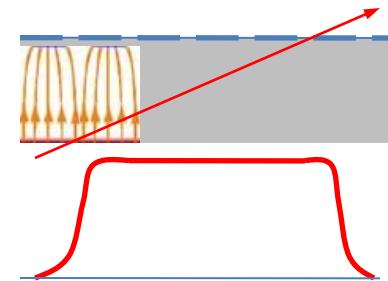
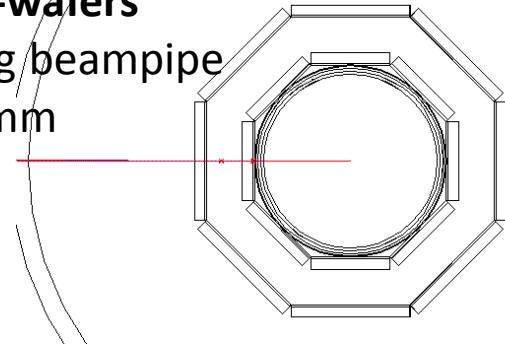
Si wafer coverage (30-100 mRad) $\rightarrow z$ range 150 – 500 mm

Assuming Si strip pitch = 100 μm (fire 100 strips @ 30mRad)
resolution is determined by the fraction of entrance strip (low z)
 \rightarrow Optimized the pitch vs the 25 μm resolution requirement
and resolution distraction for the error on mean

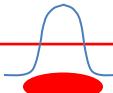
Octagon Si-wafers

surrounding beampipe

Radius 15 mm



IP $\sigma < 100 \mu\text{m}$



Octagon
Si-strip in z

Si strip disks
In Flange

LYSO + SiPM
2x2 mm^2 strips



Far-forward tagger

Bhabha scattered electrons

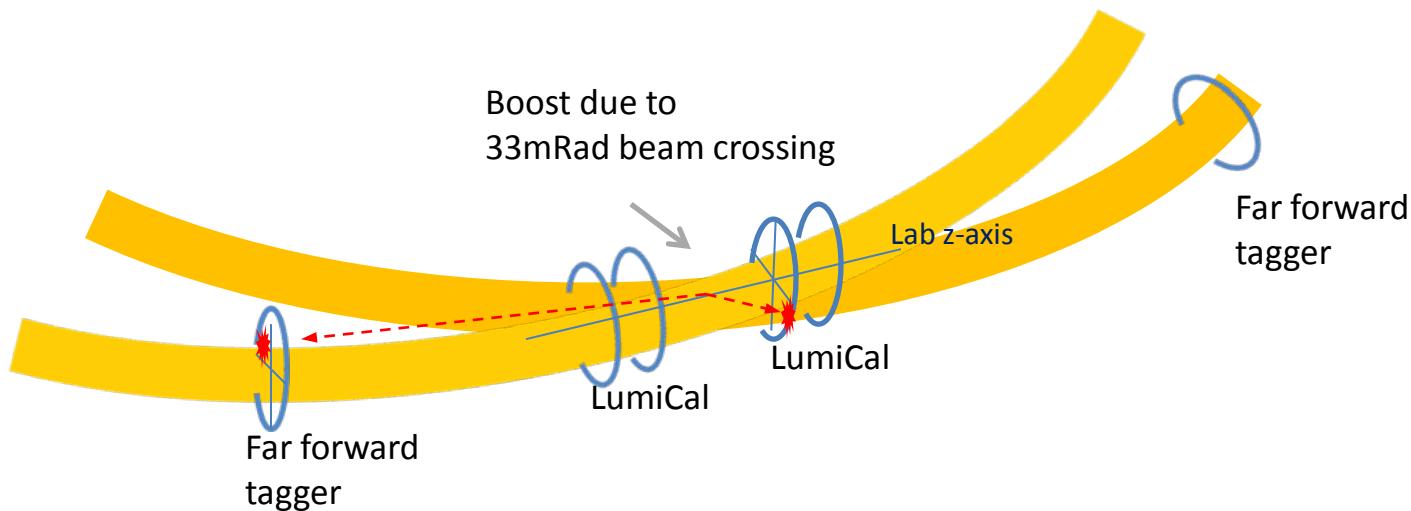
Symmetric to out-going beam-pipe, NOT the LAB frame

→ hit @ +x Lab frame : ϑ_{cms} is 16.5 mRad lower

→ LumiCal @ Lab +x region is **VERY HOT** by low ϑ beam electrons
tag Bhabha electrons by far-forward tagger
back-to-back in ϑ/φ to LumiCal hit

Detector option:

LYSO+SiPM in a ring, slide to position



Far-forward tagger

Luminosity, Bhabha 測量條件：

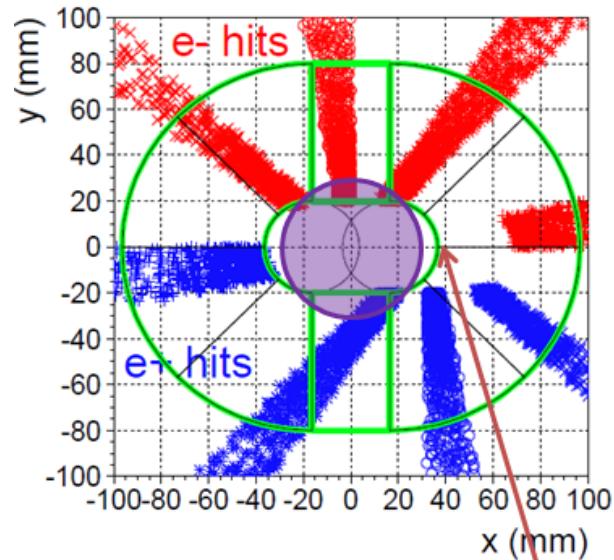
1. back-to-back colliding electrons
2. Electron(+ISR photon) = Ebeam
3. 截面 > Z(qq) at Z-pole, 41 nb

LumiCal challenge：

1. Beampipe 限制 $\theta_{\min} = 30 \text{ mRad}$
 2. Beam crossing, x-axis $\theta_{\min} = \theta_{\min} + 33/2 \text{ mrad}$
→ -x 方向 electron 被推進 beampipe, 截面 減少 1/3
- Bhabha 截面 > 41 nb 有困難

LumiCal 設計限制

1. Inner Tube, @ $z= 500 \text{ mm}$, Cone beampipe 法藍之間，
沒有材料阻擋，最乾淨的 Bhabha
→ 不能放Calo, 會導致 shower background to tracker
2. Q-pole front, @ $z=1000 \text{ mm}$, 前端有beampipe 材料，
→ full Calo, 量 electron Ebeam, Bhabha Theta 模糊
3. Q-pole outgoing beampipe, @ $Z>2000 \text{ mm}$
beam monitoring, 測量小角度 Bhabha,
閃爍體，包覆約2cm厚 2~5cm長，phi 細分割，標定 beam electron
→ 在前端單管時, -x 方向被boost 進 beampipe Bhabha，分管後能被 trigger
以 back-to-back coincident，另一端 “single electron Bhabha” 是精密測量到的
這些 Bhabha，是 33mRad 丟失掉的 1/3事例截面



Recover

**“Single Electron Bhabha”
with Far-forward
LumiMonitor**

Backup

